

Dual Channel, 16-Bit, 33 MUPS, Multispan, Multi-IO SPI DAC

FEATURES

- ▶ 16-bit resolution
- ▶ 33 MUPS rate in fast mode
- ▶ 22 MUPS rate in precision mode
- ▶ 65 ns small signal settling time to 0.1% accuracy
- ▶ 100 ns large signal settling time to 0.1% accuracy
- ▶ Ultra small glitch: < 50 pV×s
- ▶ Ultra low latency: 5 ns
- ▶ THD: -105 dB at 1 kHz
- ▶ Highly configurable output voltage span and offset
- ▶ 1.2 V and 1.8 V logic level compatible
- ▶ Single (classic), dual, and quad SPI modes
- Multiple error detectors, both analog and digital domains
- 2.5 V internal voltage reference, 10 ppm/°C maximum temperature coefficient
- ▶ 5 mm × 5 mm LFCSP

APPLICATIONS

- Instrumentation
- Hardware in the loop
- Process control equipment
- Medical devices
- Automated test equipment
- Data acquisition system
- Programmable voltage sources
- Optical communications

GENERAL DESCRIPTION

The AD3552R is a low drift, dual channel, ultra-fast, 16-bit accuracy, current output digital-to-analog converter (DAC) that can be configured in multiple voltage span ranges. The AD3552R operates with a fixed 2.5 V reference.

Each DAC incorporates three drift compensating feedback resistors for the required external transimpedance amplifier (TIA) that scales the output voltage. Offset and gain scaling registers allow for generation of multiple output span ranges, such as 0 V to 2.5 V, 0 V to 5 V, 0 V to 10 V, -5 V to +5 V, and -10 V to +10 V, and custom intermediate ranges with full 16-bit resolution.

The DAC can operate in fast mode for maximum speed or precision mode for maximum accuracy.

The serial peripheral interface (SPI) can be configured in quad SPI mode, dual synchronous SPI mode, dual SPI mode, and single SPI (classic SPI) mode with single date rate (SDR) or double data rate (DDR), with logical levels from 1.2 V to 1.8 V.

The AD3552R is specified over the extended industrial temperature range $(-40^{\circ}\text{C to } + 105^{\circ}\text{C})$.

Table 1. Related Devices

Part No.	Description
AD8675	36 V precision, 2.8 nV/√Hz rail-to-rail output operational amplifier
AD8065	High performance, 145 MHz <i>Fast</i> FET [™] operational amplifiers
ADA4807-1	3.1 nV/√Hz, 1 mA, 180 MHz, rail-to-rail input/output amplifier
LTC6655	0.25 ppm noise, low drift precision reference
ADR4525	Ultralow noise, high accuracy, 2.5 V voltage reference

FUNCTIONAL BLOCK DIAGRAM

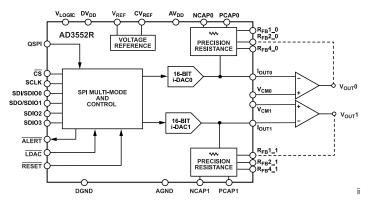


Figure 1.

Analog Devices is in the process of updating documentation to provide terminology and language that is culturally appropriate. This is a process with a wide scope and will be phased in as quickly as possible. Thank you for your patience.

Rev. B



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1/2022—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

 AV_{DD} = 5.0 V ± 5%, DV_{DD} = 1.8 V ± 5%, 1.1 V ≤ V_{LOGIC} ≤ 1.9 V, V_{REF} = 2.5 V, $-40^{\circ}C$ ≤ T_{A} ≤ +105°C, output amplifier AD8675, unless otherwise noted.

Table 2.

Parameter ¹	Symbol	Min	Тур	Max	Unit	Test Conditions/Comments
STATIC PERFORMANCE			_			
Resolution		16			Bits	
Relative Accuracy (INL)		-2		+2	LSB	5 V range only
		-4		+4	LSB	All other ranges ²
Differential Nonlinearity (DNL)		-1		+1	LSB	Precision mode: -40°C to +105°C, fast mode: 0°C to 85°C
		-2		+2	LSB	Fast mode: -40°C to +105°C
		-2		+2	LSB	0 V to 2.5 V range, fast or precision modes ²
Offset Error			0.03		%FSR	Midscale, 25°C
Offset Error Drift ²			2	8	ppm FSR/°C	0 V to 5 V and 0 V to 10 V ranges
			4	16	ppm FSR/°C	All other ranges
Full-Scale Error			0.04		%FSR	25°C
Full-Scale Error Drift ²			1	5	ppm FSR/°C	0 V to 5 V and 0 V to 10 V ranges
			4	12	ppm FSR/°C	All other ranges
Zero-Scale Error ³			0.05		%FSR	25°C
Zero-Scale Error Drift ²			3.5	8	ppm FSR/°C	0 V to 5 V and 0 V to 10 V ranges
			7	16	ppm FSR/°C	All other ranges
Total Unadjusted Error (TUE)		-0.5		+0.5	%FSR	j ,
DC Power Supply Rejection Ratio (PSRR)			0.6		mV/V	DAC code = midscale
DC Crosstalk			3		μV/V	Full-scale step
DUTPUT CHARACTERISTICS						'
Output Current	I _{OUT} x		1.6		mA	Absolute value
REFERENCE OUTPUT	100111					
Output Voltage		2.492	2.5	2.508	V	At 25°C, over lifetime
Voltage Reference Temperature			3	10	ppm/°C	,
Coefficient (TC) ⁴			Ū		PP, 0	
Output Impedance			50		mΩ	
Output Voltage Noise			2.7		μV rms	0.1 Hz to 10 Hz
Output Voltage Noise Density			173		nV/√ Hz	f = 1 kHz, no load on V _{REF}
			164		nV/√ Hz	f = 10 kHz, no load on V _{RFF}
Capacitive Load Stability ²				10	μF	, KEI
Load Regulation			50		μV/mA	At 25°C
Output Current Load Capability			±8		mA	
Line Regulation			135		μV/V	At 25°C
REFERENCE INPUT					1 :	-
Reference Current			1		μA	
Reference Input Range ²	V _{REF}	2.4	2.5	2.6	Λ,	
Reference Input Impedance	NEF		3	=-*	MΩ	
OGIC INPUTS						
Input Current	l _l	-1		+1	μA	Per pin
Input Low Voltage	V _{IL}	'		0.35 ×	V	
inpat Low Voltage	↑IL			V _{LOGIC}		
Input High Voltage	V _{IH}	0.65 ×		20010	V	
. 5 5	""	V _{LOGIC}				

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Table 2. (Continued)

Parameter ¹	Symbol	Min	Тур	Max	Unit	Test Conditions/Comments
Pin Capacitance	C _I		4		pF	
LOGIC OUTPUTS						
Output Low Voltage	V _{OL}			0.20 × V _{LOGIC}	V	I _{SINK} = 100 μA
Output High Voltage	V _{OH}	0.80 × V _{LOGIC}			V	I _{SOURCE} = 100 μA
Pin Capacitance	Co		4		pF	
POWER REQUIREMENTS						
V _{LOGIC} Pin		1.1	1.8	1.89	V	
V _{LOGIC} Current	I _{LOGIC}		1	7.5	μA	$V_{IH} = V_{LOGIC} \times 0.9$, $V_{IL} = V_{LOGIC} \times 0.1$
V _{LOGIC} Dynamic Current	I _{LOGIC_DYNAMIC}		3	5	mA	SCLK = 66 MHz, quad SPI DDR, $V_{IH} = V_{LOGIC} \times 0.65$, $V_{IL} = V_{LOGIC} \times 0.35$
DV _{DD} Pin		1.71	1.8	1.89	V	
DV _{DD} Current	I _{DVDD}		0.5	0.8	mA	
DV _{DD} Dynamic Current	I _{DVDD_DYNAMIC}		53	60	mA	SCLK = 66 MHz, quad SPI DDR, simultaneous update
AV _{DD} Pin		4.75	5	5.25	V	
AV _{DD} Current	I _{DD}		22	28.5	mA	Channel 0 and Channel 1 zero-scale, 0 V to ±5 V range
AV _{DD} Power-Down Current	I _{DD}		0.6		mA	After reset, DACs powered down
AV _{DD} Reset Current	I _{DD}		120		μA	RESET asserted

¹ See the Terminology section.

AC CHARACTERISTICS

 AV_{DD} = 5.0 V ± 5%, DV_{DD} = 1.8 V ± 5%, 1.1 V ≤ V_{LOGIC} ≤ 1.9 V, $-40^{\circ}C$ ≤ T_{A} ≤ +105°C, measured with the ADA4807-1 external amplifier, unless otherwise noted.

Table 3.

Parameter ¹	Min	Тур	Max	Unit	Test Conditions/Comments
DYNAMIC PERFORMANCE					
Output Voltage Settling Time		100		ns	2 V step, 0.1% error, 0 V to 5 V range
		75		ns	2 V step, 1% error, 0 V to 5 V range
		65		ns	60 mV step, 0.1% error, 0 V to 5 V range
		15		ns	60 mV step, 1% error, 0 V to 5 V range
Slew Rate		100		V/µs	Full-scale step, 0 V to 2.5 V range
Digital-to-Analog Glitch Impulse		50		pV×s	0 V to 5 V range, ±1 LSB change around major carry
Digital Feedthrough		25		pV×s	50 MHz clock, R _{FB} 2_x
DAC to DAC Crosstalk		6.5		pV×s/V	Full-scale step, R _{FB} 2_x
AC PSRR		80		dB	1 kHz, R _{FB} 1_x
		43		dB	1 MHz, R _{FB} 1_x
Output Noise Spectral Density		15		nV/√Hz	DAC code = midscale, external reference, 10 kHz, NCAPx = 1.2 μ F, PCAPx = none, R _{FB} 1_x
		30		nV/√Hz	R _{FB} 2_x
		60		nV/√Hz	R _{FB} 4_x

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² Guaranteed by design and characterization, not production tested.

³ Measured at zero code.

⁴ Reference temperature coefficient is calculated as per the box method.

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Table 3. (Continued)

Parameter ¹	Min	Тур	Max	Unit	Test Conditions/Comments
Output Noise		3.8		μV_{RMS}	DAC code = midscale, external reference, 1 Hz to 10 kHz, NCAPx = 1.2μ F, PCAPx = none, $R_{FB}1_x$
		7.6		μV_{RMS}	R _{FB} 2_x
		15.4		μV_{RMS}	R _{FB} 4_x
Total Harmonic Distortion (THD)		-105		dB	0 V to 5 V range, f _{OUT} = 1 kHz
		-101		dB	f _{OUT} = 10 kHz
		-84		dB	f _{OUT} = 100 kHz
Spurious-Free Dynamic Range (SFDR)		-105		dB	0 V to 5 V range, f _{OUT} = 1 kHz

¹ See the Terminology section.

TIMING CHARACTERISTICS

 $AV_{DD} = 5.0 \text{ V} \pm 5\%$, $DV_{DD} = 1.8 \text{ V} \pm 5\%$, $1.1 \text{ V} \le V_{LOGIC} \le 1.9 \text{ V}$, $-40^{\circ}C \le T_{A} \le +105^{\circ}C$, unless otherwise noted.

Table 4.

Parameter ^{1, 2}	Description	Min	Тур	Max	Unit	Test Conditions / Comments
	SCLK frequency		1717	66	MHz	Comments
f _{SCLK}	SCLK cycle time	15.2		00	ns	
t ₁	SCLK dydle tilrie SCLK half period	7.6				
t _{SCLK/2}	·	5			ns	
t ₂	CS falling edge to first SCLK rising edge	-			ns	
t ₃	Last SCLK sampling edge ³ to \overline{CS} rising edge	10			ns	
t ₄	CS falling edge from SCLK sampling edge ignored	5			ns	
t ₅	CS rising edge to SCLK rising edge ignored	5			ns	
t_6	Minimum CS high time	10			ns	
t ₇	Data setup time	2			ns	
t_8	Data hold time	2			ns	
t ₉	SCLK falling edge to SDO data valid			15	ns	1.7 < V _{LOGIC} < 1.9
				25	ns	1.1 < V _{LOGIC} < 1.7
t ₁₀	SCLK sampling edge to LDAC falling edge	7.6			ns	
t ₁₁	LDAC pulse width low	7.6			ns	
t ₁₂	CS rising edge to SDO disabled		50		ns	
t ₁₃	LDAC rising edge to CS falling edge	5			ns	
t ₁₄	RESET pulse width low	10			ns	t ₁₄ to t ₁₉ shown in Figure
t ₁₅	RESET pulse activation time			100	ns	
t ₁₆	V _{OUT} Update from CHx_DAC Register Write		12.6		ns	
t ₁₇	V _{OUT} update from LDAC falling edge		5		ns	
t ₁₈ ⁴	Wait time before DAC register access	100			ms	
t ₁₉ ⁵	Shutdown exit time		5		ms	
Update Rate	Quad SPI mode, DDR and streaming enabled, precision mode			22	MUPS ⁶	
	Quad SPI mode, DDR and streaming enabled, fast mode			33	MUPS ⁶	

¹ All input signals are specified with $t_R = t_F = 1$ ns/V (10% to 90%) and timed from a voltage level of $(V_{IL} + V_{IH})/2$.

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² Guaranteed by design and characterization, not production tested.

³ The SCLK sampling edge refers to the SCLK edge where the data is read in (sampled)

 $^{^4}$ Same timing must be expected at power-up from the instant that AV_{DD} = 4 V or DV_{DD} = 0.8 V.

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- ⁵ Time required to exit power-down to normal mode.
- ⁶ MUPS is mega updates per second.

Timing Diagrams

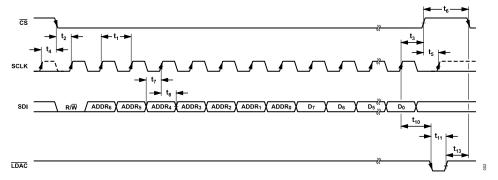


Figure 2. Classic SPI Write Operation with Single Data Rate

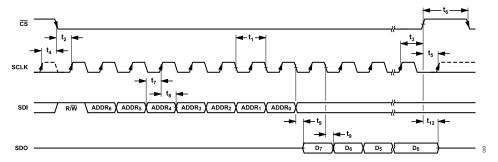


Figure 3. Classic SPI Read Operation with Single Data Rate

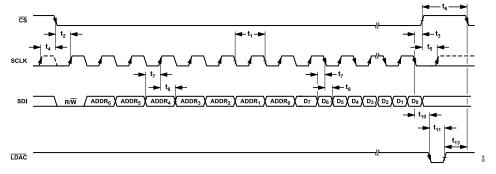


Figure 4. Classic SPI Write Operation with Double Data Rate

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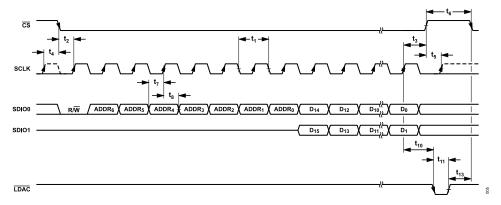


Figure 5. Dual SPI Write Operation with Single Data Rate

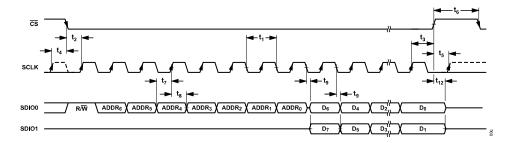


Figure 6. Dual SPI Read Operation with Single Data Rate

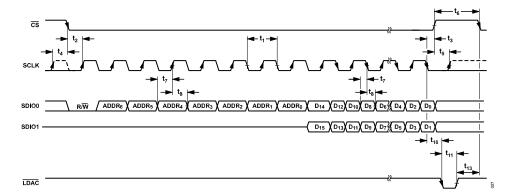


Figure 7. Dual SPI Write Operation with Double Data Rate

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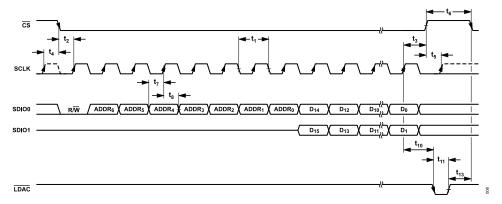


Figure 8. Dual Synchronous SPI Write Operation with Single Data Rate

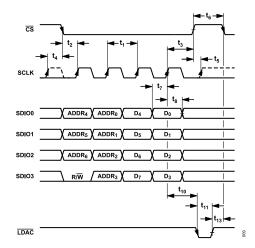


Figure 9. Quad SPI Write Operation with Single Data Rate

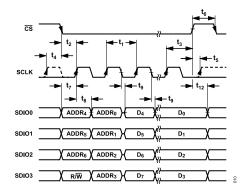


Figure 10. Quad SPI Read Operation with Single Data Rate

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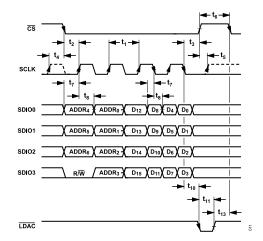


Figure 11. Quad SPI Write Operation with Double Data Rate

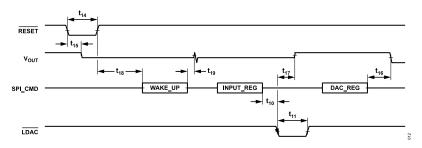


Figure 12. Start-Up Sequence Timing

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ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

Table 5.

Parameter	Rating		
AV _{DD} to AGND	-0.3 V to +6 V		
DV _{DD} to DGND	-0.3 V to +2.1 V		
AGND to DGND	-0.3 V to +0.3 V		
V _{LOGIC} to DGND	-0.3 V to DV _{DD} + 0.3 V or		
	+2.1 V (whichever is less)		
V _{REF} to AGND	-0.3 V to +3 V		
R _{FB} x_y to AGND	-18 V to +18 V		
Digital Input Voltage to DGND	-0.3 V to V _{LOGIC} + 0.3 V or +2.1 V (whichever is less)		
Operating Temperature Range			
Industrial	-40°C to +105°C		
Storage Temperature Range	-65°C to +150°C		
Maximum Junction Temperature (T _J)	125°C		
Power Dissipation	(Maximum T _J - T _A)/θ _{JA}		

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operation environment. Careful attention to PCB thermal design is required.

 θ_{JA} is the natural convection junction to ambient thermal resistance.

 θ_{JC} is the junction to case thermal resistance. Both θ_{JA} and θ_{JC} are defined by the JEDEC JESD51 standard, and their values are dependent on the test board and test environment.

Table 6. Thermal Resistance

Package Type ¹	θ_{JA}	θ_{JC}	Unit
CP-32-30	43.5	23.6	°C/W

Simulation values on JEDEC 2S2P board with 9 thermal vias, still air (0 m/sec airflow).

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

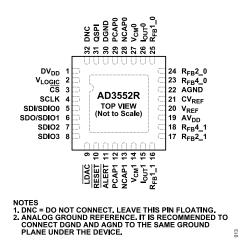


Figure 13. Pin Configuration

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Type	Description
1	DV _{DD}	S	Digital Core Power Supply. 1.8 V ± 5%.
2	V_{LOGIC}	S	Digital Interface Power Supply. 1.2 V to 1.8 V.
3	CS	DI	Chip Select, Active Low Logic Input. This is the frame synchronization signal for the input data.
4	SCLK	DI	Serial Clock Input.
5	SDI/SDIO0	DI/O	Serial Data Input in Classic SPI Mode.
			Serial Bidirectional Input/Output Bit 0 in Dual or Quad SPI Modes.
6	SDO/SDIO1	DI/O	Serial Data Output in Classic SPI Mode.
			Serial Bidirectional Input/Output Bit 1 in Dual or Quad SPI Modes.
7	SDIO2	DI/O	Serial Bidirectional Input/Output Bit 2 in Quad SPI Mode. Pull down if not used.
8	SDIO3	DI/O	Serial Bidirectional Input/Output Bit 3 in Quad SPI Mode. Pull down if not used.
9	LDAC	DI	Load DAC, Active Low Logic Input. LDAC can be operated in synchronous mode or asynchronous mode. Pulsing this pin low causes the DAC register to be updated if the input register has new data. If this pin is tied permanently low, the DAC is automatically updated when new data is written to the input register.
10	RESET	DI	Asynchronous Reset Input. Active low logic input. When RESET is low, all registers are reset to their default values and the activity on the digital interface is ignored. The AD3552R incorporates a power-on reset (POR) circuit. If this pin is not used it must be tied to
11	ALERT	DO	V _{LOGIC} . Alert Pin. Active low logic output. This pin is driven low if an alert condition is detected and it is not masked by the corresponding bit in the mask register. This pin has an internal configurable pull-up resistor.
12	PCAP1	AI/O	Noise Reduction Capacitor for DAC1, Optional. Capacitor connected to AV _{DD} .
13	NCAP1	AI/O	Noise Reduction Capacitor for DAC1, Optional. Capacitor connected to GND.
14	V _{CM} 1	AO	Common Mode Voltage for DAC1. Analog input/output.
15	I _{OUT} 1	AI/O	DAC1 Output Current.
16	R _{FB} 1_1	AI/O	Hardware Gain Selection for DAC1, Gain = 1.
17	R _{FB} 2 _1	AI/O	Hardware Gain Selection for DAC1, Gain = 2.
18	R _{FB} 4 _1	AI/O	Hardware Gain Selection for DAC1, Gain = 4.
19	AV _{DD}	S	Analog Power Supply. 5 V ± 5%.
20	V_{REF}	AI/O	Voltage Reference, 2.5 V. Input when using external reference, output or floating when using internal reference.
21	CV _{REF}	AI/O	Decoupling Capacitor for Internal Reference, Optional.
22	AGND	S	Analog Ground Reference. It is recommended to connect DGND and AGND to the same ground plane under the device.
23	R _{FB} 4 _0	AI/O	Hardware Gain Selection for DAC0, Gain = 4.
24	R _{FB} 2 _0	AI/O	Hardware Gain Selection for DAC0, Gain = 2.
25	R _{FB} 1 _0	AI/O	Hardware Gain Selection for DAC0, Gain = 1.
26	I _{OUT} 0	AI/O	DAC0 Output Current.
27	V _{CM} 0	AO	Common Mode Voltage for DAC0 External TIA.

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 7. Pin Function Descriptions (Continued)

Pin No.	Mnemonic	Туре	Description
28	NCAP0	AI/O	Noise Reduction Capacitor for DAC0, Optional. Capacitor connected to GND.
29	PCAP0	AI/O	Noise Reduction Capacitor for DAC0, Optional. Capacitor connected to AV _{DD} .
30	DGND	S	Digital Ground Reference. It is recommended to connect DGND and AGND to the same ground plane under the device.
31	QSPI	DI	QSPI Mode Enable. Digital input. A high level enables quad SPI interface mode.
32	DNC	DNC	Do Not Connect. Leave pin floating.
EPAD			Exposed Pad. Connect this pad to AGND and provide thermal vias, as explained in the Layout Guidelines section.

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TYPICAL PERFORMANCE CHARACTERISTICS

 $AV_{DD} = 5 \text{ V}$, $DV_{DD} = V_{LOGIC} = 1.8 \text{ V}$, external voltage reference, temperature = 25°C (ambient), decoupling as outlined in the Power Supply Recommendations section, unless otherwise noted.

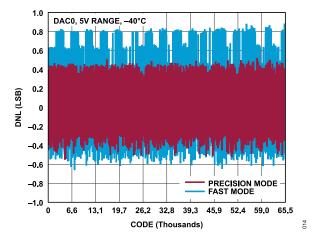


Figure 14. DNL vs. Code, 0 V to 5 V Range, ~40°C, Fast Mode and Precision

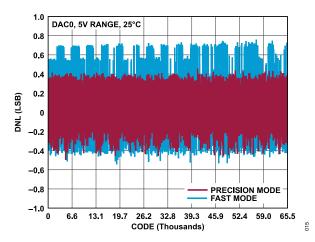


Figure 15. DNL vs. Code, 0 V to 5 V Range, 25°C, Fast Mode and Precision

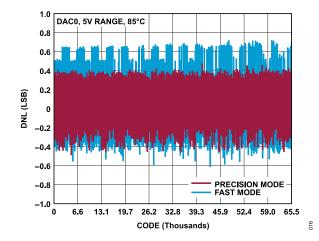


Figure 16. DNL vs. Code, 0 V to 5 V Range, 85°C, Fast Mode and Precision Mode

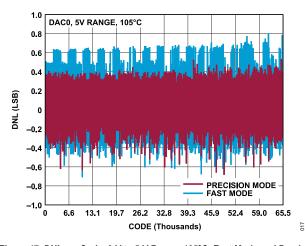


Figure 17. DNL vs. Code, 0 V to 5 V Range, 105°C, Fast Mode and Precision Mode

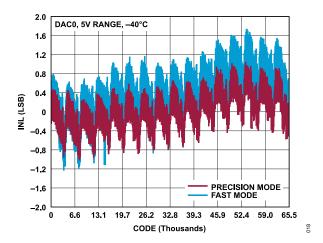


Figure 18. INL vs. Code, 0 V to 5 V Range, -40°C, Fast Mode and Precision

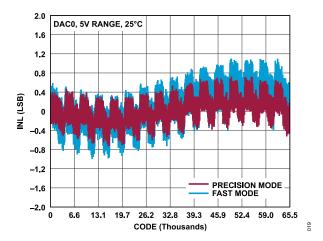


Figure 19. INL vs. Code, 0 V to 5 V Range, 25°C, Fast Mode and Precision Mode

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TYPICAL PERFORMANCE CHARACTERISTICS

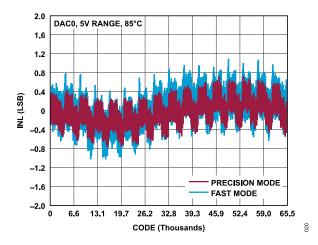


Figure 20. INL vs. Code, 0 V to 5 V Range, 85°C, Fast Mode and Precision Mode

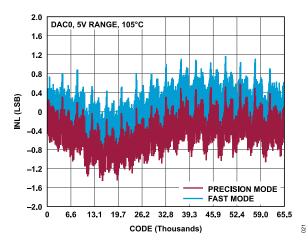


Figure 21. INL vs. Code, 0 V to 5 V Range, 105°C, Fast Mode and Precision Mode

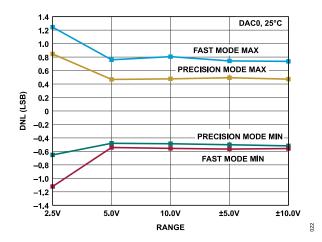


Figure 22. DNL vs. Range, Fast Mode and Precision Mode

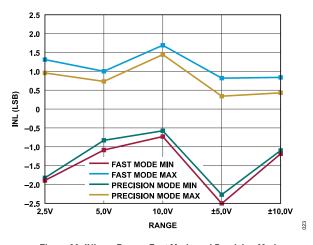


Figure 23. INL vs. Range, Fast Mode and Precision Mode

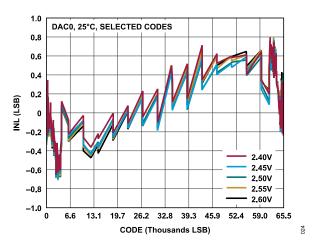


Figure 24. INL vs. Code, Reference Voltage

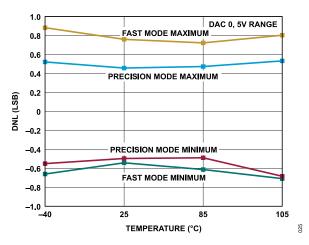


Figure 25. DNL vs. Temperature

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TYPICAL PERFORMANCE CHARACTERISTICS

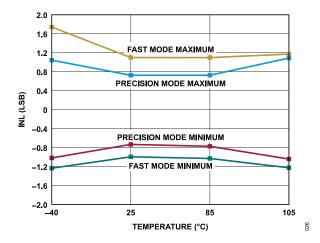


Figure 26. INL vs. Temperature

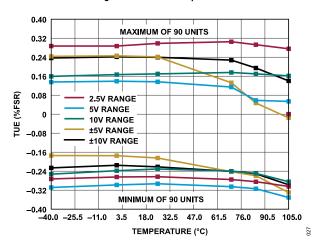


Figure 27. TUE vs. Temperature

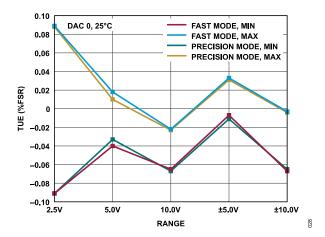


Figure 28. TUE vs. Range

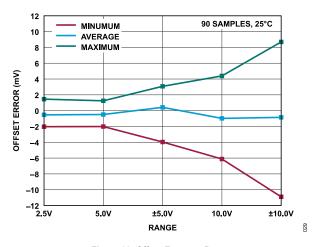


Figure 29. Offset Error vs. Range

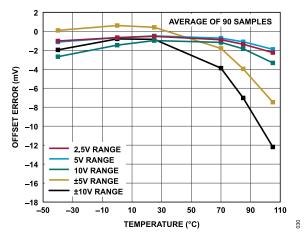


Figure 30. Offset Error vs. Temperature

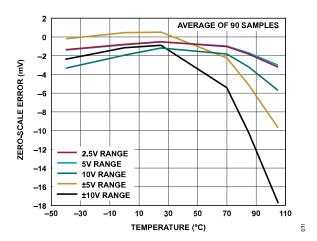


Figure 31. Zero-Scale Error vs. Temperature

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TYPICAL PERFORMANCE CHARACTERISTICS

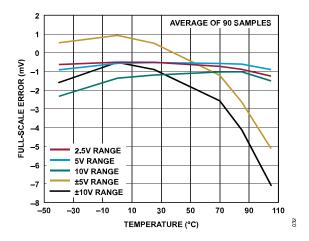


Figure 32. Full-Scale Error vs. Temperature

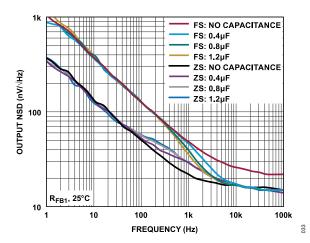


Figure 33. Output NSD vs. Frequency, PCAPx and NCAPx Capacitor Values

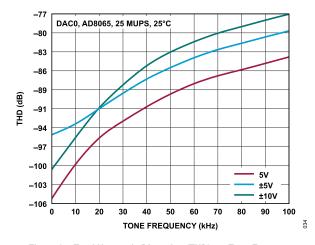


Figure 34. Total Harmonic Distortion (THD) vs. Tone Frequency

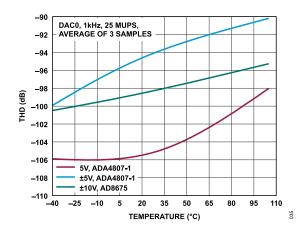


Figure 35. THD vs. Temperature

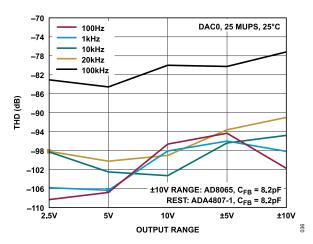


Figure 36. THD vs. Output Range

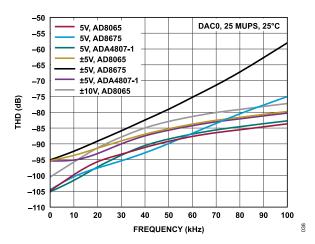


Figure 37. THD vs. Frequency, Amplifier

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TYPICAL PERFORMANCE CHARACTERISTICS

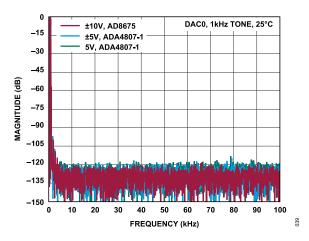


Figure 38. Fast Fourier Transform (FFT) with 1 kHz Sinewave, 25 MUPS

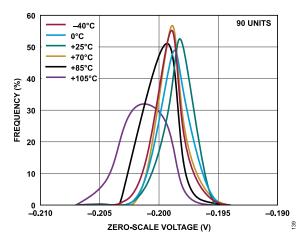


Figure 39. Zero-Scale Voltage Distribution, 0 V to 2.5 V Range

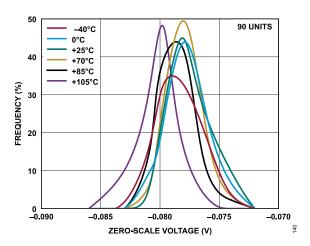


Figure 40. Zero-Scale Voltage Distribution, 0 V to 5 V Range

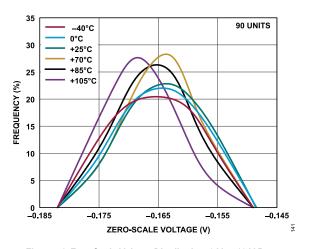


Figure 41. Zero-Scale Voltage Distribution, 0 V to 10 V Range

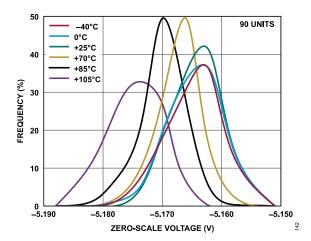


Figure 42. Zero-Scale Voltage Distribution, -5 V to +5 V Range

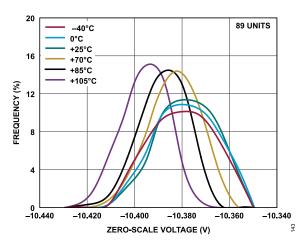


Figure 43. Zero-Scale Voltage Distribution, -10 V to +10 V Range

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TYPICAL PERFORMANCE CHARACTERISTICS

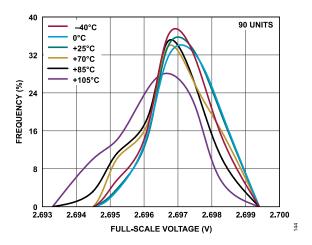


Figure 44. Full-Scale Voltage Distribution, 0 V to 2.5 V Range

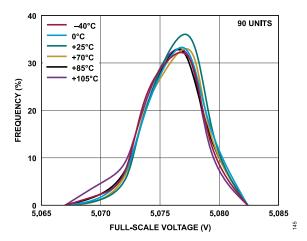


Figure 45. Full-Scale Voltage Distribution, 0 V to 5 V Range

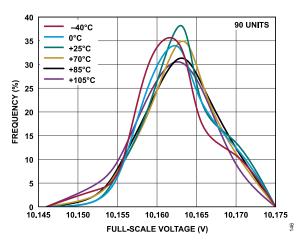


Figure 46. Full-Scale Voltage Distribution, 0 V to 10 V Range

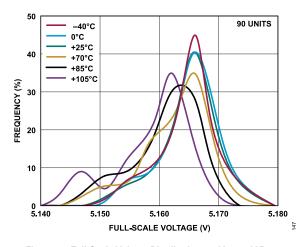


Figure 47. Full-Scale Voltage Distribution, -5 V to +5 V Range

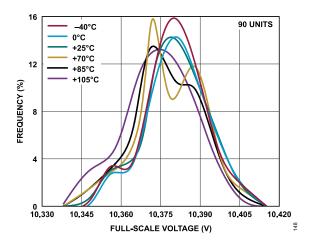


Figure 48. Full-Scale Voltage Distribution, -10 V to +10 V Range

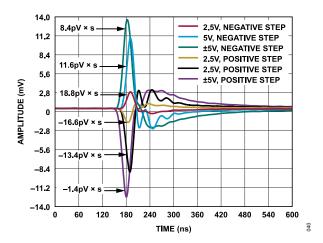


Figure 49. Digital to Analog Glitch

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TYPICAL PERFORMANCE CHARACTERISTICS

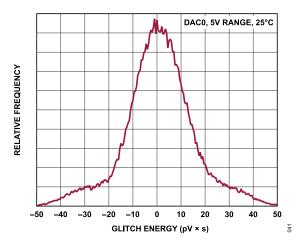


Figure 50. Digital to Analog Glitch Energy Histogram

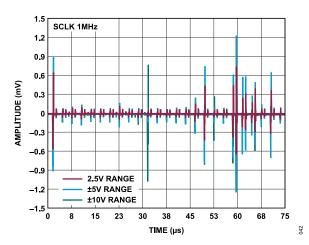


Figure 51. Digital Feedthrough

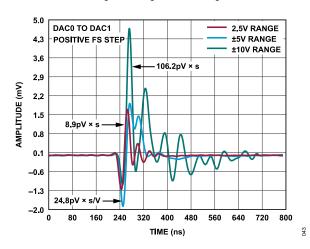


Figure 52. DAC-to-DAC Crosstalk

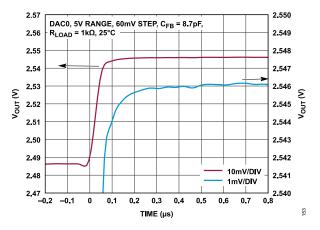


Figure 53. Small Signal Settling Time, 0 V to 5 V Range

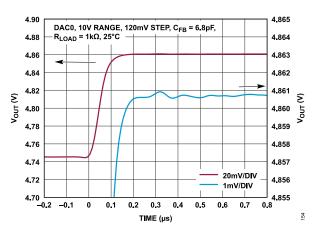


Figure 54. Small Signal Settling Time, 0 V to 10 V Range

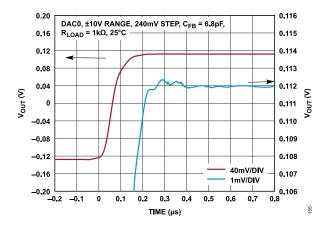


Figure 55. Small Signal Settling Time, −10 V to +10 V Range

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TYPICAL PERFORMANCE CHARACTERISTICS

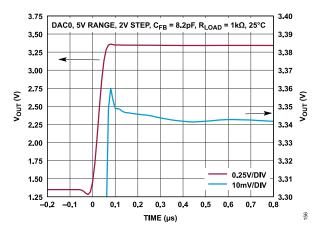


Figure 56. Large Signal Settling Time, 0 V to 5 V Range

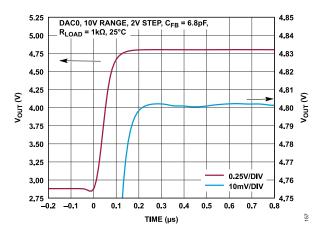


Figure 57. Large Signal Settling Time, 0 V to 10 V Range

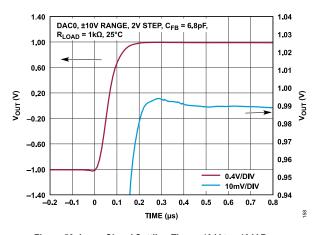


Figure 58. Large Signal Settling Time, -10 V to +10 V Range

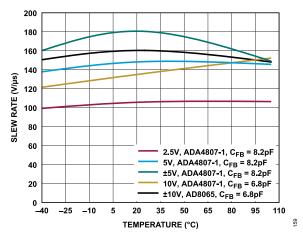


Figure 59. Slew Rate vs. Temperature

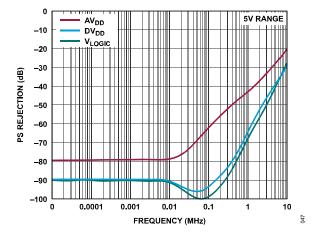


Figure 60. AC PSRR

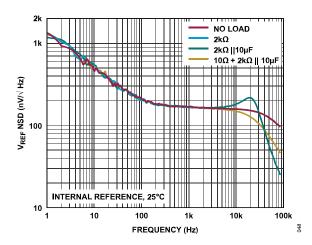


Figure 61. Reference Voltage (V_{REF}) NSD vs. Frequency, Load Impedance

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TYPICAL PERFORMANCE CHARACTERISTICS

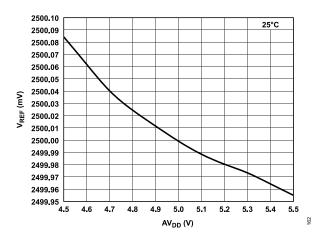


Figure 62. V_{REF} vs. Supply (AVDD)

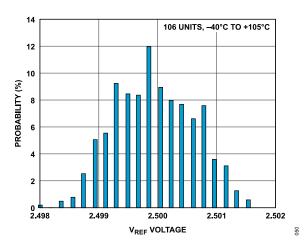


Figure 63. Reference Voltage Spread

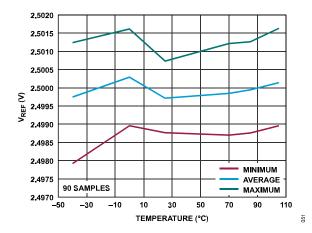


Figure 64. V_{REF} vs. Temperature

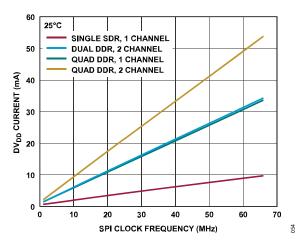


Figure 65. DV_{DD} Current vs. SPI Clock Frequency, SPI Mode

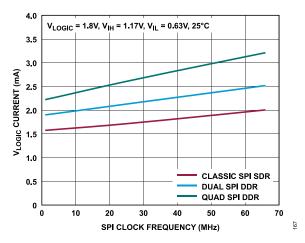


Figure 66. V_{LOGIC} Current vs. SPI Clock Frequency, SPI Mode

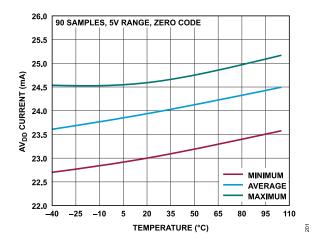


Figure 67. AV_{DD} Current vs. Temperature

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TYPICAL PERFORMANCE CHARACTERISTICS

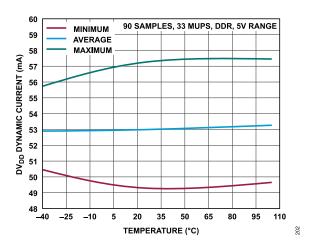


Figure 68. DV_{DD} Dynamic Current vs. Temperature

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TERMINOLOGY

Relative Accuracy or Integral Nonlinearity (INL)

For the DAC, relative accuracy or integral nonlinearity is a measurement of the maximum deviation, in LSBs, from a straight line passing through the endpoints of the DAC transfer function.

Differential Nonlinearity (DNL)

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes.

Offset Error

Offset error is the vertical deviation from the ideal transfer function after the gain error has been compensated. Offset error is expressed in mV. In the AD3552R, offset error is measured at midscale. The comparison between the ideal output and the actual output is performed at midscale.

Offset Error Drift

The offset error drift is a measurement of the relative variation of the offset with temperature. It is expressed in ppm/°C. Total offset at a given temperature is calculated as

$$Offset_T = Offset_{25^{\circ}C} + \frac{TC \times (T - 25) \times V_{RANGE}}{10^6}$$

Full-Scale and Zero-Scale Error

These errors measure the deviation from the ideal value at full scale and zero scale, at 25°C. The error is expressed as % of full-scale range (FSR). In the case of the AD3552R, the ideal value is calculated as the average of a sufficiently high number of samples.

Full-Scale and Zero-Scale Error Drift

These parameters measure the variation of the zero-scale and full-scale voltage as a function of the temperature, relative to the ideal zero-scale and full-scale voltages. They are expressed in ppm/°C. The total deviation over temperature is calculated using the same formula used for the offset.

DC PSRR and AC PSRR

PSRR indicates how the output of the DAC is affected by changes in the supply voltage. PSRR is the ratio of the change in V_{OUT} to a change in the supplies for midscale output of the DAC. DC PSRR is measured in mV/V, and AC PSRR is measured in dB. V_{REF} is held at 2.5 V, and the supplies are varied by ± 200 mV p-p.

Output Voltage Settling Time

Output voltage settling time is the amount of time it takes for the output of a DAC to settle to a specified level within a given accuracy for a given step change. Typically, it is evaluated for a small step and a large step to account for the effect of amplifier slewing.

Digital-to-Analog Glitch Impulse

Digital-to-analog glitch impulse is the impulse injected into the analog output when the input code in the DAC register changes state. It is normally specified as the area of the glitch in nV × sec and is measured when the digital input code is changed by 1 LSB.

Digital Feedthrough

Digital feedthrough is a measure of the impulse injected into the analog output of the DAC from the digital inputs of the DAC, but it is measured when the DAC output is not updated. Digital feedthrough is specified in nV × sec and measured with a full-scale code change on the data bus, which means from all 0s to all 1s and vice versa.

Output Noise Spectral Density

Noise spectral density is a measurement of the internally generated random noise. Noise is measured at the DAC output when it is loaded with the midscale code and using an ideal external reference. Noise is also measured at the output of the internal reference, if available. Noise density is expressed in nV/\sqrt{Hz} . Figure 33 depicts the spectral density of the noise in the 1/f region and the flat (broadband) region, whereas the specification quoted in Table 2 pertains to the flat region.

Total Harmonic Distortion (THD)

THD is the difference between the sine wave played by the DAC and an ideal sine wave of the same frequency and amplitude. The deviation from an ideal sine wave is due to time and amplitude discretization and nonlinear distortion. THD is measured as the power ratio of the sum of harmonic components to the fundamental component. It is expressed in dB.

Voltage Reference Temperature Coefficient (TC)

Voltage reference TC is a measure of the change in the reference output voltage with a change in temperature. The reference TC is calculated using the box method, which defines the TC as the maximum change in the reference output over a given temperature range expressed in ppm/°C, as shown in the following equation:

$$TC = \left(\frac{V_{REF_MAX} - V_{REF_MIN}}{V_{REF_NOM} \times TEMP_RANGE}\right) \times 10^6$$
 (1)

where:

 V_{REF_MAX} is the maximum reference output measured over the total temperature range.

V_{REF_MIN} is the minimum reference output measured over the total temperature range.

V_{REF_NOM} is the nominal reference output voltage, 2.5 V. *TEMP_RANGE* is the specified temperature range, −40°C to +105°C.

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TERMINOLOGY

DC Crosstalk

DC crosstalk is the DC change in the output level of one DAC in response to a change in the output of another DAC. It is measured with a full-scale output change on one DAC (or soft power-down and power-up) while monitoring another DAC kept at midscale. It is expressed in $\mu V/V$.

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PRODUCT DESCRIPTION

The AD3552R is a dual channel, 16-bit, 33 MUPS DAC with programmable output ranges and a 2.5 V internal reference.

The AD3552R has the following two update modes:

- ▶ Fast Mode: data written in this mode is 16 bits long, resulting in a single-channel update rate of 33 MUPS. The DNL specification is valid for the reduced temperature range defined in Table 2. The data for this mode is written in the registers ending in 16B.
- Precision Mode: data written in this mode is 24 bits long, resulting in a single-channel update rate of 22 MUPS. The DNL specification is guaranteed over the full operating temperature range. The data for this mode is written in the registers ending in 24B.

The AD3552R offers a versatile SPI interface capable of operating in classic, dual, and quad SPI modes with single or double data rate. The AD3552R features multiple error checkers, both in the analog and digital domains to guarantee a safe operation.

DAC ARCHITECTURE

The AD3552R uses a current steering DAC architecture with a V_{REF} voltage of 2.5 V. The DAC current is converted to voltage by means of an external TIA.

Figure 69 shows the internal block diagram.

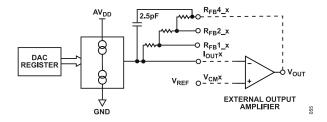


Figure 69. DAC Channel Architecture Block Diagram

Table 8. Predefined Output Span Ranges and Corresponding Feedback Resistor

The state of the s							
R _{FB} x_y	CH0_CH1_OUTPUT_RANGE	Output Span	CHx_GAIN_SCALING_P	CHx_GAIN_SCALING_N	CHx_OFFSET	V _{ZS} (V)	V _{FS} (V)
R _{FB} 1_y	0x000	2.5 V	0	3	-48	-0.198	2.701
	0x001	5 V	0	0	0	-0.078	5.077
R _{FB} 2_y	0x010	10 V	0	0	495	-0.165	10.163
	0x011	±5 V	0	0	-495	-5.165	5.166
R _{FB} 4_y	0x100	±10 V	0	0	-245	-10.382	10.380

The TIA feedback loop is closed by hardwiring the V_{OUT} pin to any of the available $R_{FB}x_y$ pins. The $R_{FB}x_y$ value sets the maximum voltage span that can be achieved. These voltage spans can be decreased using the gain scaling registers and repositioned within the supply rails of the TIA using the offset registers.

PREDEFINED OUTPUT VOLTAGE SPANS

The AD3552R comes with five predefined voltage spans that are selected using the CH0_CH1_OUTPUT_RANGE register. The selected span must be in accordance with the feedback resistor being used, as shown in Table 8. The CHx_GAIN_SCALING_P, CHx_GAIN_SCALING_N, and CHx_OFFSET parameters do not have to be set because their preset values are provided only as starting points for the user to create custom range values. Setting a voltage span that is not achievable with the current R_{FB}x_y resistor results in an incorrect voltage value.

There is approximately a 3% overrange equally split on each end of the span to ensure that the nominal range is covered in any condition.

If the predefined voltage spans do not fit the intended application, custom spans can be defined using the gain scaling and offset registers as described in the Custom Output Voltage Span section.

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CUSTOM OUTPUT VOLTAGE SPAN

In addition to the predefined output span ranges configured via the CH0_CH1_OUTPUT_RANGE register, the output span range can be customized by programming the offset and gain registers in conjunction with the external feedback resistor. The CHx_RANGE_OVERRIDE bit must be set in the CHx_GAIN register to override the predefined range and offset values. Gain is configured as a combination of two parameters, CHx_GAIN_SCALING_P and CHx_GAIN_SCALING_N, in the CHx_GAIN register. The absolute value and the sign of the offset are configured in the CHx_OFFSET register and the lower bits of the CHx_GAIN register, as shown in Table 10.

The zero-scale output voltage (V_{OUT_ZS}) and full-scale output voltage (V_{OUT_FS}) are calculated using the following equations:

$$V_{OUT\ ZS} = 2.5 + 1.6 \times R_{FB} \times (Offset - Gain_P)$$

$$V_{OUT\ FS} = 2.5 + 1.6 \times R_{FB} \times (Offset + Gain_N)$$

where:

$$Gain_P = \frac{1}{2^{CHx_GAIN_SCALING_P}}$$

$$Gain_N = \frac{1}{2^{CHx_GAIN_SCALING_N}}$$

$$Offset = \frac{OFFSET_POLARITY \times CHx_OFFSET}{1024}$$

OFFSET_POLARITY = 1 if CHx_OFFSET_POLARITY = 0 and -1 if CHx_OFFSET_POLARITY = 1, and the value of R_{FB} depends on which R_{FR}x y pin is connected, as shown in Table 9.

Table 9. Value of Resistors on R_{FB}x_y pins

15 3 1				
Pin Resistor Value (kΩ)				
R _{FB} 1_y	1.610938			
R _{FB} 2_y	3.228125			
R _{FR} 4 y	6.488125			

Table 10. Mapping of Offset Value

Item	Register	Bit	Field Name
Offset Sign	CHx_GAIN	2	CHx_OFFSET_POLARITY
Offset Bit 8	CHx_GAIN	0	CHx_OFFSET[8]
Offset Bit 7 to Bit 0	CHx_OFFSET	[7:0]	CHx_OFFSET

At zero offset, a custom range is centered at V_{CM} (2.5 V). The offset register allows moving the range up or down by 25% of its span. That is, a 10 V range spans from -2.5 V to 7.5 V at zero offset, and can be shifted by ± 2.5 V using the offset register and polarity bit. The gain scaling configuration does not affect the amplitude of the offset.

While several combinations of R_{FB} and gain scaling values are possible to define a given range, it is recommended to use the lowest possible value of R_{FB} to minimize the noise density at the output of the TIA.

TRANSFER FUNCTION

The conversion of the digital code to the DAC output current follows a linear relation with the code in plain binary. The ideal output current, in mA, is given by the following equation:

$$I_{OUTx} = 1.6 \times \left(Gain_P - Offset - \frac{D}{2^{16}} \times \left(Gain_P + Gain_N\right)\right)$$

where:

D is the decimal equivalent of the binary code that is loaded in the DAC register..

Offset, $Gain_P$, and $Gain_N$ are according to the definitions given in the Custom Output Voltage Span section.

The conversion of current to voltage is performed in the external TIA. If the internal feedback resistor is used, the output voltage follows the following equation:

$$V_{OUT} = V_{CM} - R_{FB} \times I_{OUT}$$

where:

 V_{CM} is the common-mode voltage at the V_{CM}x pin that is connected to the noninverting input of the TIA, nominally 2.5 V. R_{FB} is according to the definition given in Table 9.

VREF

The AD3552R has an internal 2.5 V voltage reference with a 3 ppm/°C temperature coefficient that is enabled at power-up. The V_{REF} pin is in high impedance at power-up to avoid electrical problems. If the internal reference must be used externally, the REFERENCE_VOLTAGE_SEL bits in the REFERENCE_CONFIG register must be written to enable the V_{REF} output as described in Table 11.

When the external reference is selected, the V_{REF} pin behaves as an input.

Table 11. Voltage Reference Selection

REFERENCE_VOLTAGE_SEL	Source	V _{REF} I/O
00	Internal	Floating
01	Internal	2.5 V
10	External	Input
11	External	Input

SPI REGISTER MAP ACCESS

SPI Frame Synchronization

The $\overline{\text{CS}}$ signal frames data during an SPI transaction. A falling edge on $\overline{\text{CS}}$ enables the digital interface and initiates an SPI transaction. Each SPI transaction consists of at least one instruction phase and data phase, as described in the Instruction Phase section and the Data Phase section. For all SPI transactions, data is aligned MSB first. Deasserting $\overline{\text{CS}}$ during an SPI transaction terminates part or all of the data transfer and disables the digital interface. If $\overline{\text{CS}}$ is deasserted (returned high) after one or more register addresses are issued, those registers are written or read, but any partially

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addressed register is ignored. Figure 70 and Figure 71 outline the stages of a basic SPI write and read frame, respectively, for the AD3552R in register mode.

Detailed timing diagrams for register read and write operations are shown in Figure 2 through Figure 11. The timing specification is given in the Timing Characteristics section.

The AD3552R SPI protocol is flexible and can be configured to suit the needs of a variety of digital hosts. Data from multiple registers can be accessed in a single SPI frame, enabling efficient device configuration. All the different access modes are described in the Single Instruction Mode section and the Streaming Mode section.

Instruction Phase

Every SPI frame starts with an instruction phase. The instruction phase immediately follows the falling edge of \overline{CS} that initiates the SPI transaction.

The instruction phase consists of a read/write bit (R/W) followed by a register address word. Setting R/W low initiates a write instruction, whereas setting R/W high initiates a read instruction. The register address word specifies the address of the register to be accessed. The register address word is 7 bits in length (7-bit addressing) by default. If required, 15-bit addressing can be enabled by setting the SHORT_INSTRUCTION bit to 0 in the INTER-FACE_CONFIG_B register. If the user is using single instruction mode, each register read or write transaction in a single SPI frame also begins with an instruction phase. If the user is using streaming mode, only one instruction phase is required per SPI frame to access a set of consecutive registers. See the Single Instruction Mode section and the Streaming Mode section for instructions on selecting and using these modes.

Data Phase

The data phase immediately follows the instruction phase, as shown in Figure 70 and Figure 71. The data phase can include the data for a single-byte register, a multibyte register, or multiple registers depending on the selected registers and access modes. See the Single Instruction Mode section, Streaming Mode section, and Address Direction section for descriptions of how these modes affect the read and write data in the data phase.

In a write operation, the content of the addressed register is updated immediately after the SCLK edge, which shifts in the last bit of the register data, regardless if it is a one-byte, two-byte, or three-byte register. Multibyte registers cannot be written partially, as explained in the Multibyte Registers section.

In a read operation, the content of the addressed register starts shifting out on the first SCLK edge of the data phase.

Data must be written to the AD3552R configuration registers in full bytes to ensure they are updated. If the data phase of an SPI write transaction does not include the entire byte of data for the register being updated, the contents of the register are not updated, and the

CLOCK_COUNTING_ERROR bit in the INTERFACE_STATUS_A register is set.

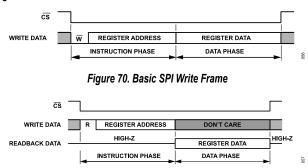


Figure 71. Basic SPI Read Frame

Multibyte Registers

Some AD3552R registers consist of 2 or 3 bytes of data stored in adjacent addresses and are referred to as multibyte registers. Multibyte registers end with a 16B or 24B suffix when they are 2 bytes or 3 bytes, respectively.

When writing to a multibyte register of the AD3552R, all bytes must be transferred in a single SPI transaction. For this reason, the STRICT_REGISTER_ACCESS bit in the INTERFACE_CONFIG_C register is read only and set to 1. If an SPI write transaction to a multibyte register is attempted on a per byte basis, the register contents are not updated and the PARTIAL_REGISTER_ACCESS bit in the INTERFACE_STATUS_A register is set. A write transaction to a multibyte register of the AD3552R takes effect after the 24th or 16th SCLK edge of the data phase, which shifts in the last bit of the register data.

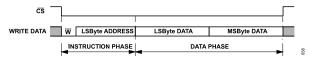


Figure 72. Multibyte Register Write with Ascending Addressing

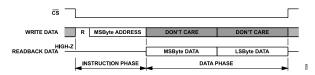


Figure 73. Multibyte Register Read with Descending Addressing

The address of a multibyte register always depends on the ADDR_DIRECTION bit in the INTERFACE_CONFIG_A register (see the Address Direction section for more details). With descending addressing, the first byte accessed in the data phase must be the most significant byte of the multibyte register, and each subsequent byte corresponds to the data in the next lower address. With ascending addressing, the first byte accessed in the data phase must be the least significant byte of the multibyte register, and each subsequent byte corresponds to the data in the next higher address.

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Multibyte registers can be read in a single SPI transaction or each byte can be addressed separately. If an SPI read transaction to a multibyte register is attempted on a per byte basis, the PARTI-AL_REGISTER_ACCESS bit in the INTERFACE_STATUS_A register is set. For example, the VENDOR_ID register is 2 bytes long, and the addresses of its least significant byte and most significant byte are 0x0C and 0x0D, respectively. Figure 72 and Figure 73 show write and read transactions to a multibyte register (2 bytes) for address ascending and descending mode, respectively. See the Address Direction section for more information on selecting address descending (auto-decrementing) or ascending (auto-incrementing).

Address Direction

The address direction option is used to control whether the register address is set to automatically increment (address ascending) or decrement (address descending) when transferring multiple bytes of data in a single data phase (for example, when accessing multibyte registers, as shown in Figure 72 and Figure 73, or when accessing multiple registers with streaming mode, as shown in Figure 75).

Address direction is selected with the ADDR_DIRECTION bit in the INTERFACE_CONFIG_A register. If ADDR_DIRECTION is set to 0, the address decrements after each byte is accessed. If ADDR_DIRECTION is set to 1, the address increments after each byte is accessed.

When accessing multibyte registers, use descending addresses to shift in the most significant byte first.

Multibyte registers from Address 0x29 onwards can only be accessed in descending mode.

Single Instruction Mode

When the SINGLE_INSTRUCTION bit in the INTERFACE_CON-FIG_B register is set to 1, streaming mode is disabled, and single instruction mode is enabled. In single instruction mode, the data phase only contains data for a single register, and each data phase must be followed by a new instruction phase, even if \overline{CS} remains low. Single instruction mode allows the digital host to quickly read from and write to registers with nonadjacent addresses in a single SPI frame, whereas streaming mode only allows either reading or writing to contiguous registers without pulsing \overline{CS} high to initiate a new instruction phase.

Figure 74 shows an example of an SPI transaction in single instruction mode with the following register accesses:

- ▶ Sets the output range.
- ► Enables the output stage.
- ▶ Reads the CHIP_TYPE register.

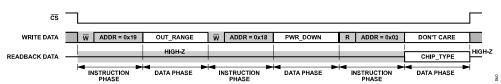


Figure 74. Single Instruction Mode Register Access Example with Address Descending

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Streaming Mode

When the SINGLE_INSTRUCTION bit in the INTERFACE_CON-FIG_B register is set to 0, single instruction mode is disabled and streaming mode is enabled. In streaming mode, multiple registers with adjacent addresses can be accessed with a single instruction phase and data phase, allowing efficient access of contiguous regions of memory (for example, during initial device configuration). The AD3552R is configured in streaming mode by default.

When in streaming mode, each SPI frame consists of a single instruction phase and the following data phase contains data for multiple registers with adjacent addresses. A starting register address is specified by the digital host in the instruction phase, and this address is automatically incremented or decremented (based on the address direction setting) after each byte of data is accessed. The data phase can, therefore, be multiple bytes long, and each consecutive byte of read or write data corresponds to the next higher or lower register address (for ascending and descending address direction, respectively).

When writing or reading from a multibyte register in streaming mode with address ascending, the user must address the least significant byte of the register in the instruction phase. The data phase starts transferring data from the least significant byte in first place.

When writing or reading from a multibyte register in streaming mode with the address descending, the user must start addressing the most significant byte of the register in the instruction phase. The data phase starts transferring the most significant byte in first place.

Figure 75 shows the instruction and data phase when using streaming mode with address descending to write some registers of the AD3552R starting from Address 0x16. The length of the data phase determines the number of data bytes to be transferred to consecutive addresses. \overline{CS} is brought high at the end of the write transaction (in Figure 75, the end of the write transaction occurs after Address 0x02).

Figure 76 shows the instruction and data phase when using streaming mode with address descending to read some registers of the AD3552R starting from Address 0x16. The length of the data phase determines the number of data bytes to be transferred to consecutive addresses. \overline{CS} is brought high at the end of the read

transaction (in Figure 76, the end of the read transaction occurs after Address 0x02).

The STREAM_MODE register can be used to specify a range of consecutive registers to loop through in the data phase. Looping allows the digital host to repeatedly read from or write to a set of registers (for example, CHx_DAC_16B register at Address 0x29 to Address 0x2C) as efficiently as possible. When accessing register addresses after and including Address 0x29, the address direction must always be set as descending.

If STREAM_MODE is set to 0, looping is disabled and the following occurs:

- ▶ If address direction is set to descending, the address decrements until it reaches 0x00. On the subsequent byte accesses, the address is set to the top of the addressable space (Address 0x4B). Note that restrictions may apply in terms of SPI mode access depending on the register address.
- ▶ If address direction is set to ascending, the address increments until it reaches the top of the addressable space (Address 0x4B). On the subsequent byte access, the address is reset to 0x00. Note that restrictions may apply in terms of SPI mode access depending on the register address. Multibyte registers greater than 0x29 do not update in ascending mode.

If STREAM_MODE is set to a value other than 0, looping is enabled and the value corresponds to the number of bytes to be accessed in the data phase before the address loops back to the value specified in the address phase. An example is shown in Figure 77, where the CH0_DAC_16B register is accessed twice using the looping feature.

The value of the STREAM_MODE register can be preserved or reset to 0 at the end of the transaction (when \overline{CS} returns high) depending on the value of the STREAM_LENGTH_KEEP_VALUE bit in the TRANSFER_REGISTER, as shown in Table 12. This feature allows writing the same range of registers continuously within the same transaction, which is useful for waveform playback.

Table 12. Stream Mode Autoreset

STREAM_LENGTH_KEEP_VALUE	STREAM_MODE Register
0	Autoreset
1	Keeps previous value

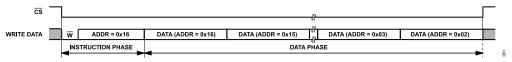


Figure 75. Streaming Mode Register Write with Address Descending

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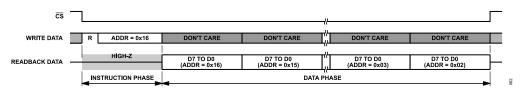


Figure 76. Streaming Mode Register Read with Address Descending

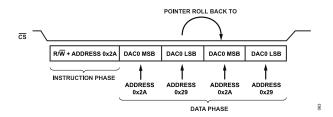


Figure 77. Looping Enabled with Address Descending and STREAM_MODE = 2

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CRC Error Detection

The AD3552R features an optional CRC to provide error detection for SPI transactions between the digital host (master) and the AD3552R (slave).

CRC error detection allows SPI masters and slaves to detect bit transfer errors with significant reliability. The CRC algorithm involves using a seed value and polynomial division to generate a CRC code. The master and slave both calculate the CRC code independently and compare it to determine the validity of the transferred data.

The AD3552R uses the CRC-8 standard with the following polynomial:

$$x^8 + x^2 + x + 1 \tag{2}$$

CRC error detection is enabled with the CRC_EN and CRC_EN_B bits in the INTERFACE_CONFIG_C register. The value of CRC_EN is only updated if CRC_EN_B is set to the CRC_EN inverted value in the same register write instruction. Therefore, to enable the CRC, CRC_EN must be set to 0b01 while CRC_EN_B is set to 0b10 in the same write transaction.

To disable the CRC, CRC_ENABLE must be set to 0b00 while CRC_ENABLE_B is set to 0b11 in the same write transaction. Writing inverted values to two separate fields reduces the chances of CRC being enabled by mistake. \overline{CS} must be brought high at the end of the enable or disable write. The transaction following the enabling of the CRC must already include the CRC byte, regardless if it is a write or read operation. A register write transaction that disables CRC must still include the CRC code at the end, but the transaction following the disabling of the CRC does not have to include the CRC byte.

Figure 78 and Figure 79 show how a CRC code is appended at the end of a write or read transaction, respectively, in single SPI mode (classic mode). For register writes, the digital host must generate the CRC by performing the calculation described in Equation 2 on the seed, the address, and the data. The AD3552R performs the

same calculation and shifts out the CRC code on SDO at the same time as the host. The transaction is free of error if both CRC codes match. For register reads, the host calculates the CRC on the seed, the address, and a zero padding while the AD3552R calculates the CRC on the seed, the address, and the readout data. Both nodes then shift out the CRC code at the same time so that it can be checked on both sides.

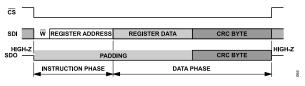


Figure 78. Basic SPI Write Frame with CRC

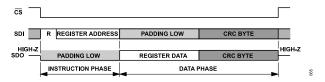


Figure 79. Basic SPI Read Frame with CRC

When accessing multibyte registers with CRC error detection enabled, the CRC code is placed after all of the bytes of register data.

When CRC error detection is enabled, the AD3552R does not update its register contents in response to a register write transaction unless it receives a valid CRC code at the end of the register data. If the CRC code is invalid, or if the digital host fails to transmit the CRC code, the AD3552R does not update its register contents, and the INVALID_OR_NO_CRC flag in the INTERFACE_STATUS_A register is set. The INVALID_OR_NO_CRC flag is cleared when 1 is written to this bit, and the correct CRC is required for the write to clear the bit to take effect.

Table 13 shows the seed value used in the CRC code calculation and how it is calculated for both single instruction mode and streaming mode.

Table 13. CRC Seed Values and Extent of CRC Calculation

Table 16. One deed values and Extent of One Calculation				
SPI Transaction Type	Pin	Single Instruction Mode	Streaming Mode, First Data Phase	Streaming Mode, Subsequent Data Phases
Read	SDI	0xA5, instruction phase, padding	0xA5, instruction phase, padding	No CRC sent
	SDO	0xA5, instruction phase, read data	0xA5, instruction phase, read data	Least significant byte of address, read data
Write	SDI	0xA5, instruction phase, write data	0xA5, instruction phase, write data	Least significant byte of address, write data
	SDO	0xA5, instruction phase, write data	0xA5, instruction phase, write data	Least significant byte of address, write data

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When using single instruction mode, every CRC code in an SPI frame uses 0xA5 as the seed value to prevent stuck at fault conditions for Address 0x00.

When using streaming mode, the first CRC code in an SPI frame also uses 0xA5 as the seed value, but subsequent CRC codes in the same frame are calculated using the least significant byte of the register address being accessed in the SPI transaction as the seed value.

Because enabling the CRC in single SPI (classic) mode requires that the SDO pin shifts out the CRC calculated by the AD3552R,

the transaction must respect the limitations of a read operation, which is that DDR is disabled. CRC is not allowed in synchronous dual SPI mode.

In dual and quad SPI modes, the CRC is appended at the end of the byte or multibyte register transaction but the CRC is generated only by the controller (write) or by the AD3552R (read), as shown in Figure 80 and Figure 81.

When CRC error detection is enabled, do not use streaming mode, including looping, if the range of registers being addressed includes unused or reserved registers.

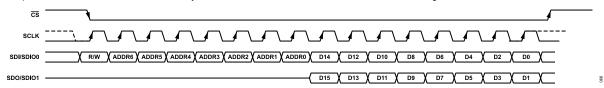


Figure 80. Dual SPI Transaction with CRC

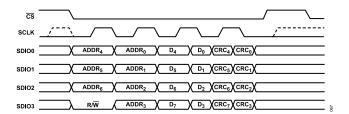


Figure 81. Quad SPI Transaction with CRC

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SERIAL INTERFACE

The AD3552R implements a versatile serial interface that is compatible with several SPI modes. When the QSPI pin is tied low, the interface is configured in single SPI (classic SPI) mode by default and can be switched to dual SPI or synchronous dual SPI mode by acting on the configuration registers. When the QSPI pin is pulled high, the interface is configured in quad SPI mode. DDR can be enabled in any of the modes to duplicate the transfer speed in the data phase.

Clock polarity (CPOL) can be 1 or 0, but clock phase (CPHA) must be always 0. These combinations correspond to SPI Mode 0 and Mode 3, which are applicable when the SPI interface is in single data rate (SDR) mode.

Single SPI (Classic) Mode

In single SPI (classic) mode, the SDI/SDIO0 and SDO/SDIO1 data lines are unidirectional. The SDI signal behaves as an input to transfer data from master to slave and the SDO signal behaves as an output to transfer data from slave to master, as shown in Figure 82. Single SPI (classic) mode is compatible with SPI Mode 0 and Mode 3, as well as with completely synchronous interfaces, such as synchronous serial port (SPORT™). See Figure 2 for a timing diagram of a typical write sequence. See the AN-1248 Application Note, SPI Interface, for more information about the classic SPI mode.

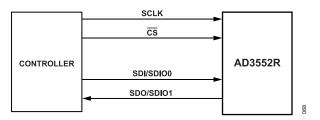


Figure 82. Single SPI (Classic SPI) Connection

Dual SPI Mode

In dual SPI mode, the SDI/SDIO0 and SDO/SDIO1 data lines are bidirectional, as shown in Figure 83. During the data phase, the R/\overline{W} bit of the instruction phase defines the direction of the data lines. During the instruction phase, the data lines are always configured as inputs. In dual SPI mode, consecutive bits are serialized in groups of two, as shown in Figure 84.

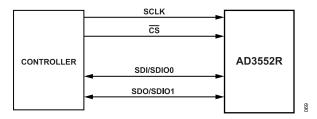


Figure 83. Dual SPI Connection

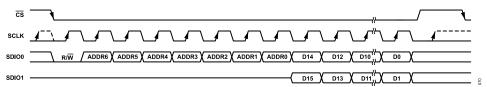


Figure 84. Dual SPI Mode

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Synchronous Dual SPI Mode

In synchronous dual SPI mode, similar to dual SPI mode, the SDI/SDI00 and SDO/SDI01 data lines are bidirectional, as shown in Figure 83. During the data phase, the R/\overline{W} bit of the instruction phase defines the direction of the data lines. During the instruction phase, the data lines are always configured as inputs. In contrast to dual SPI mode, in synchronous dual SPI mode each SDIO line serializes the data of one DAC, as shown in Figure 85.

In this mode, the data transferred on the SDIO0 line is loaded to the register addressed in the instruction phase, while the data transferred on the SDIO1 line is loaded to the register at the address given in the instruction phase that is incremented by 3

bytes in precision mode or the address given in the instruction phase that is incremented by 2 bytes in fast mode.

Synchronous dual SPI mode can only be used to write the CHx_DAC_16B, CHx_DAC_24B, CHx_INPUT_16B, and CHx_INPUT_24B registers. To write other registers within the secondary region, classic SPI must be used.

This transfer mode is useful when the controller is made up of two entities, each one addressing one DAC with a single bit stream, or when the CPU cannot serialize the data in groups of two bits. This mode also allows the simultaneous update of both channels without any time skew when the $\overline{\text{LDAC}}$ signal is not used.

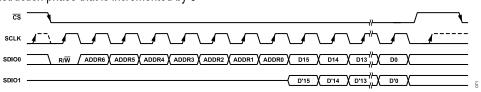


Figure 85. Synchronous Dual SPI Mode

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Quad SPI Mode

In quad SPI mode, the SDI/SDIO0, SDO/SDIO1, SDIO2, and SDIO3 data lines are bidirectional, as shown in Figure 86. During the data phase, the R/\overline{W} bit of the instruction phase defines the direction of the data lines. During the instruction phase, the data lines are always configured as inputs. In quad SPI mode, consecutive bits are serialized in groups of four, as shown in Figure 87.

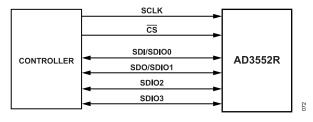


Figure 86. Quad SPI Connection

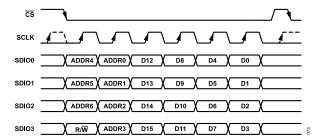


Figure 87. Quad SPI Mode

Double Data Rate (DDR)

Irrespective of the SPI mode being used, DDR can be enabled by setting the SPI_CONFIG_DDR bit in the INTERFACE_CONFIG_D register, which allows sampling data during the data phase on both clock edges, as shown in Figure 88. After this mode is enabled, all data must be written using DDR.

DDR is only usable in the data phase during write operations. In readback operations, the SPI_CONFIG_DDR bit is ignored, and data is transferred from the AD3552R to the controller in single data rate, as shown in Figure 2, Figure 6, and Figure 10.

After changing the SPI mode or the SPI_CONFIG_DDR bit, $\overline{\text{CS}}$ must be brought high and a new access cycle must be started in the appropriate mode.

All valid SPI mode combinations are listed in Table 14.

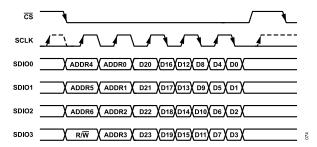


Figure 88. Quad SPI Mode DDR on a 24-Bit Register

Table 14. SPI Mode Combinations

SPI Mode	MULTI_IO_MODE	DUAL_SPI_SYNCHRONOUS_E	N SPI_CONFIG_DDR
Single SPI SDR	00	0	0
Single SPI DDR	00	0	1
Dual SPI SDR	01	0	0
Dual SPI DDR	01	0	1
Synchronous Dual SPI SDR	01	1	0
Synchronous Dual SPI DDR	01	1	1
Quad SPI SDR ¹	Not applicable	0	0
Quad SPI DDR ¹	Not applicable	0	1

¹ Enabled by the QSPI pin only.

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Register Map SPI Access Modes

The register map is divided in two regions, primary and secondary.

The registers related to interface configuration, DAC configuration, and error flags are comprised in the primary region from Address 0x0 to Address 0x1E. If the QSPI pin is low, this region can only be accessed in classic SPI mode with or without DDR, regardless of the value of MULTI IO MODE in the TRANSFER REGISTER.

The registers affecting the output value of the DAC are comprised in the secondary region from Address 0x28 to Address 0x4B. This region can be accessed in any of the SPI modes, with or without DDR.

If the QSPI pin is high, the interface is configured in full quad SPI mode for any communication to primary or secondary region registers.

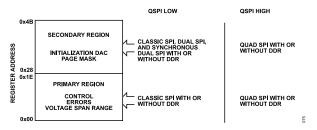


Figure 89. Register Access Modes

SDIO Drive Strength

The driving strength of the SDIO lines on the SDIO3, SDIO2, SDO/SDIO1, and SDI/SDIO0 pins can be configured to four different levels by setting the SDIO_DRIVE_STRENGTH bits in the INTERFACE_CONFIG_D register.

Higher drive strength value corresponds to a faster signal slew rate, as shown in Figure 90. However, higher slew rate means higher peak current and higher digital noise in the system. The default value is medium low strength.

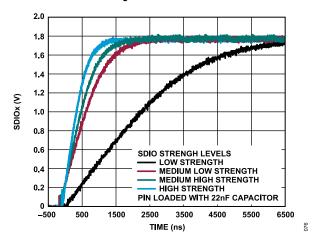


Figure 90. Driving Strength Options

DAC UPDATE MODES

There are several ways to update the DAC outputs, synchronously or asynchronously, simultaneously, or individually.

A synchronous update occurs when the change of the DAC output is triggered by an external signal, such as $\overline{\text{LDAC}}$, which can be common to many devices. In this case, the controller loads a value in the input register that is later transferred to the DAC register on the falling edge of the $\overline{\text{LDAC}}$ signal, causing the simultaneous update of all $V_{\text{OLIT}}x$ signals.

If the synchronous update is only required in one of the DACs, the LDAC signal can be masked using the HW_LDAC_MASK_CHx bits in the HW_LDAC_16B or the HW_LDAC_24B registers depending on the precision mode.

An asynchronous update occurs when the change of the DAC output follows an operation on the register set. In this case, the change is aligned with the SCLK edge that shifts the last register bit in. The update can be on one DAC or both DACs simultaneously following the several combinations described in Table 15.

Page mask registers can be used to transfer the same data to one or both channels, according to the value of the SEL_CHx bits in the CH_SELECT_16B or CH_SELECT_24B registers. Writing to the DAC_PAGE register transfers the data to the CHx_DAC registers and writing to the INPUT_PAGE register transfers the data to the CHx_INPUT registers. The data flow between registers is summarized in Figure 91.

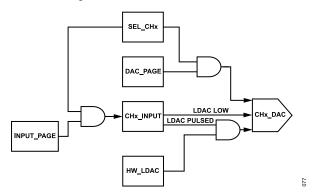


Figure 91. DAC Data Flow Between Registers

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Table 15. DAC Update Modes

SPI Mode	Register Written	LDAC Pin	Synchronous	Simultaneous	Notes
Quad, Dual and Single SPI	CHx_INPUT	Falling edge	Yes	Yes	No LDAC mask applied
Quad, Dual and Single SPI	CHx_INPUT	Falling edge	Yes	No	LDAC mask applied, HW_LDAC register
Quad, Dual and Single SPI	CHx_INPUT	High	No	Yes	Write to SW_LDAC triggers the update
Quad, Dual and Single SPI	CHx_INPUT	Low	No	No	Output updates automatically
Quad, Dual and Single SPI	CHx_DAC	Not applicable	No	No	Output updates immediately
Quad, Dual and Single SPI	DAC_PAGE	Not applicable	No	Yes	Same data written to the DAC registers selected using the SEL_CHx bits in the CH_SELECT_16B register or the CH_SELECT_24B register
Quad, Dual and Single SPI	INPUT_PAGE	Not applicable	No	No	Same data written to input registers selected using the SEL_CHx bits in the CH_SELECT_16B register or the CH_SELECT_24B register
Synchronous SPI	CHx_INPUT	Falling edge	Yes	Yes	No LDAC mask applied
Synchronous SPI	CHx_INPUT	Falling edge	Yes	No	LDAC mask applied, HW_LDAC register
Synchronous SPI	CHx_INPUT	Low	No	Yes	No LDAC mask applied
Synchronous SPI	CHx_DAC	Not applicable	No	Yes	Output updates immediately

POWER-DOWN

Each of the two DAC cores in the AD3552R can be disabled to reduce power consumption when the channel is not in use. Control is performed using the CHx_DAC_POWERDOWN bits in the POWERDOWN_CONFIG register. The DAC core is powered down after reset and becomes active on the first update.

RESET

The AD3552R implements three different ways to reset the device. All three methods trigger the same reset procedure internally, except for the difference explained in the Software Reset section.

Power-On Reset

The device integrates a power-on reset (POR) circuit that monitors AV_{DD} and DV_{DD} . Whenever AV_{DD} falls below 4 V or DV_{DD} falls below 1.3 V, an internal reset pulse is generated. This circuit ensures that the chip is correctly initialized at power-up or after a power dip.

Reset Pin

A low level on the \overline{RESET} pin sets the chip in default mode, clearing the values of all registers, setting the $I_{OUT}x$ and $V_{CM}x$ outputs to 0 V, and keeping the SPI lines in high impedance. When the \overline{RESET} line is released (returns high), the device starts executing the initialization procedure that can take up to 100 ms (t_{18} time). After reset, the DAC core is in power-down mode and the $I_{OUT}x$ and $V_{CM}x$ outputs are still at 0 V.

During reset, the external transimpedance amplifier is still powered up and it may produce some glitch in the V_{OUT} signal, depending on the sequencing of the supplies.

Software Reset

The device can be reset from the SPI interface by setting the SW_RESET_MSB and SW_RESET_LSB bits in the INTER-FACE_CONFIG_A register. The main difference between the software reset and the hardware reset using the RESET pin is that the former does not affect the INTERFACE_CONFIG_A register. The SW_RESET_MSB and SW_RESET_LSB bits clear after the reset operation has concluded.

ERROR DETECTION

The AD3552R can detect abnormal conditions both in the analog and digital domains. These errors are reported in the INTER-FACE_STATUS_A and ERR_STATUS registers. The list of the errors mapped to the ERR_ALARM_MASK register and its corresponding source is shown in Table 16. The errors listed in Table 16 can assert the ALERT pin if it is not masked in the ERR_ALARM_MASK register. The ALERT pin is also asserted after reset and in case of initialization failure.

The error bits in the INTERFACE_STATUS_A and ERR_STATUS registers are sticky and keep their value until cleared with a write 1 operation. That is, to clear an error bit, write 1 on that specific bit location.

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Table 16. Alarm Mask Register and Corresponding Error Source

Bit Number	Alarm Mask Register Bit Name	Error Source Register Name	Error Source Bit Name
6	REF_RANGE_ALARM_MASK	ERR_STATUS	REF_RANGE_ERR_STATUS
5	CLOCK_COUNT_ALARM_MASK	INTERFACE_STATUS_A	CLOCK_COUNTING_ERROR
4	MEM_CRC_ALARM_MASK	ERR_STATUS	MEM_CRC_ERR_STATUS
3	SPI_CRC_ERR_ALARM_MASK	INTERFACE_STATUS_A	INVALID_OR_NO_CRC
2	WRITE_TO_READ_ONLY_ALARM_MASK	INTERFACE_STATUS_A	WRITE_TO_READ_ONLY_REGISTER
1	PARTIAL_REGISTER_ACCESS_ALARM_MASK	INTERFACE_STATUS_A	PARTIAL_REGISTER_ACCESS
0	REGISTER_ADDRESS_INVALID_ALARM_MASK	INTERFACE_STATUS_A	REGISTER_ADDRESS_INVALID

ERR_STATUS Register

V_{REF} Detection

The REF_RANGE_ERR_STATUS bit in the ERR_STATUS register is set when the reference voltage drops below 1 V for more than 5 ms. The error is detected irrespective of the reference voltage source, whether it is generated internally or provided externally via the V_{REF} pin. This feature is useful to detect an interruption in the external reference voltage or an overload condition on the V_{REF} pin when the internal reference is shared with another device.

SPI Mode Error

The SPI mode error is produced during streaming when the address pointer crosses the boundary between the secondary and the primary region with the SPI interface configured in synchronous dual SPI mode or dual SPI mode because this region can only be accessed in quad SPI mode or classic SPI mode. The DUAL_SPI_STREAM_EXCEEDS_DAC_ERR_STATUS bit is set in the ERR_STATUS register.

Register CRC

The AD3552R includes an internal CRC for the register map and the read only memory (ROM). The CRC is executed every 4.1 µs, and only includes the primary region of the register map because the secondary region is expected to be continuously written. The CRC can be disabled by clearing the MEM_CRC_EN bit in the INTERFACE_CONFIG_D register. If a CRC error is detected, the MEM_CRC_ERR_STATUS bit is set in the ERR_STATUS register. It is advisable to reset the device if this error occurs.

Reset Status

The RESET_STATUS bit in the ERR_STATUS register indicates that the AD3552R has been reset, either internally (POR or SW reset) or externally (via the RESET pin). The RESET_STATUS bit is set when the POR completes correctly. It is useful to detect unexpected reset conditions, such as a dip in power supply, and take corrective actions.

The RESET_STATUS bit causes the assertion of the ALERT pin and it is not maskable. Therefore, it must be cleared after reset or power-up to be able to detect new events via the ALERT signal.

INTERFACE_STATUS_A Register

Device Busy

The INTERFACE_NOT_READY bit in the INTERFACE_STATUS_A register is not an error, but a status bit. This bit can be polled to know when the device is ready to receive data from the controller.

SPI Clock Counter

The error reported in the CLOCK_COUNTING_ERR bit is produced when the number of SCLK cycles is not in accordance with the amount required to shift a multiple of 8 bits, taking into account the SPI mode (quad, dual, or single) and the DDR mode. The CLOCK_COUNTING_ERR bit is set in the ERR_STATUS register.

Valid combinations are shown in Table 17.

Table 17. Clock Cycles Required to Transfer One Byte

SPI Mode	DDR	Clock Cycles for 1 Byte
Single SPI	No	8
Single SPI	Yes	4
Dual SPI	No	4
Dual SPI	Yes	2
Quad SPI	No	2
Quad SPI	Yes	1

SPI CRC

The INVALID_OR_NO_CRC bit in the INTERFACE_STATUS_A register is set when the CRC is enabled and the CRC byte in the SPI transaction is missing or it does not match the calculated value. To clear this error, write 1 to this bit. Note that because CRC is enabled, this SPI transaction must have a valid CRC code to succeed.

Write to Read Only Register

If the host tries to write to a read only register, the WRITE_TO_READ_ONLY_REGISTER bit field is asserted in the INTERFACE_STATUS_A register. To clear this error, write 1 to the WRITE_TO_READ_ONLY_REGISTER bit.

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Partial Register Access

The PARTIAL_REGISTER_ ACCESS bit in the INTERFACE_STA-TUS_A register is set when a multibyte register is accessed for read or write partially, which means that the transaction ends before all the bytes of a multibyte register have been accessed. To clear this error, write 1 to the PARTIAL_REGISTER_ ACCESS bit.

Invalid Access

When the host tries to access an invalid register address, the REG-ISTER_ADDRESS_INVALID bit is set in the INTERFACE_STA-TUS A register. To clear this error, write 1 to this bit.

ALERT PIN

When one of the errors listed in Table 16 is detected and its corresponding bit in the ERR_ALARM_MASK register is set to 0, the ALERT pin is asserted. This pin can be used as an interrupt line for the CPU to take action when an error condition arises.

In addition, the ALERT pin is asserted when the RESET_STATUS bit is asserted in the ERR_STATUS register. This condition is not maskable. Therefore, the RESET_STATUS bit must be cleared after initialization to use the ALERT pin. If the pin remains asserted after clearing all the error sources, it means that there has been an error during the initialization of the device and it must be power cycled.

The \overline{ALERT} pin requires a pull-up resistor that can be provided externally or internally. The chip incorporates an internal 2.5 k Ω

pull-up resistor that can be enabled by setting the ALERT_ENA-BLE PULLUP bit in the INTERFACE CONFIG D register.

The ALERT pin is deasserted when all the errors are cleared in their corresponding registers.

DEVICE ID

The AD3552R includes numerous registers providing silicon related information. The following registers can be used to identify that the correct chip type and version are assembled:

- ▶ CHIP_TYPE
- ▶ PRODUCT ID L
- ▶ PRODUCT ID H
- ▶ CHIP GRADE
- ▶ SPI REVISION
- ▶ VENDOR L
- ▶ VENDOR H

SUMMARY OF INTERFACE ACCESS MODES

Finding the correct SPI mode can be difficult given the number of modes and the restrictions on specific registers or memory regions, specially when not using QSPI. To facilitate the implementation of the driver in the CPU, a decision tree is presented in Figure 92. Figure 92 depicts how the driver must proceed depending on the configuration of the interface and the registers being accessed when the QSPI pin is low. The decision tree is much simpler when QSPI is high, as shown in Figure 93.

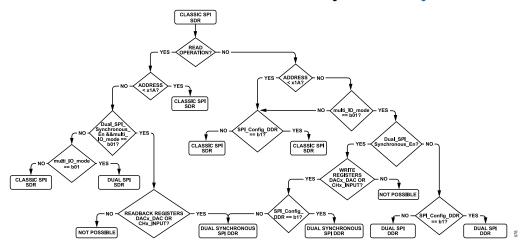


Figure 92. Register Access Modes when QSPI Pin is Low

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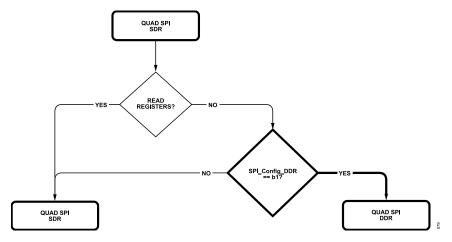


Figure 93. Register Access Modes when QSPI Pin is High

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REGISTER SUMMARY

Register List

Table 18. Register Summary

Address	Name	Description	Reset	Access
0x00	INTERFACE_CONFIG_A	Interface Configuration A Register.	0x10	R/W
)x01	INTERFACE_CONFIG_B	Interface Configuration B Register.	0x08	R/W
)x02	DEVICE_CONFIG	Device Configuration Register.	0x00	R
)x03	CHIP_TYPE	Chip Type Register.	0x04	R
)x04	PRODUCT_ID_L	Product ID Low Register.	0x08	R
)x05	PRODUCT_ID_H	Product ID High Register.	0x40	R
)x06	CHIP_GRADE	Chip Grade Register.	0x05	R
Ox0A	SCRATCH_PAD	Scratch Pad Register.	0x00	R/W
)x0B	SPI_REVISION	SPI Revision Register.	0x83	R
)x0C	VENDOR_L	Vendor ID Low Register.	0x56	R
)x0D	VENDOR_H	Vendor ID High Register.	0x04	R
x0E	STREAM_MODE	Stream Mode Register.	0x00	R/W
)x0F	TRANSFER_REGISTER	Transfer Configuration Register.	0x00	R/W
)x10	INTERFACE_CONFIG_C	Interface Configuration C Register.	0x23	R/W
)x11	INTERFACE_STATUS_A	Interface Status A Register.	0x00	R/W
)x14	INTERFACE_CONFIG_D	Interface Configuration D Register.	0x04	R/W
)x15	REFERENCE_CONFIG	Reference Configuration Register.	0x00	R/W
)x16	ERR_ALARM_MASK	Error Alarm Mask Register.	0x00	R/W
)x17	ERR_STATUS	Error Status Register.	0x01	R/W
)x18	POWERDOWN_CONFIG	Power-Down Configuration Register.	0x00	R/W
)x19	CH0_CH1_OUTPUT_RANGE	Output Range Register.	0x00	R/W
x1B	CH0_OFFSET	Channel 0 Offset Register.	0x00	R/W
x1C	CH0_GAIN	Channel 0 Gain Register.	0x00	R/W
x1D	CH1_OFFSET	Channel 1 Offset Register.	0x00	R/W
x1E	CH1_GAIN	Channel 1 Gain Register.	0x00	R/W
)x28	HW_LDAC_16B	Hardware LDAC Mask Register, Fast Mode.	0x00	R/W
)x29	CH0_DAC_16B	DAC Register for Channel 0, Fast Mode.	0x0000	R/W
)x2B	CH1_DAC_16B	DAC Register for Channel 1, Fast Mode.	0x0000	R/W
)x2D	DAC_PAGE_16B	DAC Page Register, Fast Mode.	0x0000	R/W
)x2F	CH_SELECT_16B	Channel Select for Page Registers, Fast Mode.	0x00	R/W
)x30	INPUT_PAGE_16B	Input Page Register, Fast Mode.	0x0000	R/W
)x32	SW_LDAC_16B	Software LDAC Register, Fast Mode.	0x00	W
)x33	CH0_INPUT_16B	Input Register for Channel 0, Fast Mode.	0x0000	R/W
)x35	CH1_INPUT_16B	Input Register for Channel 1, Fast Mode.	0x0000	R/W
)x37	HW_LDAC_24B	Hardware LDAC Mask Register, Precision Mode.	0x00	R/W
x38	CH0_DAC_24B	DAC Register for Channel 0, Precision Mode.	0x000000	R/W
x3B	CH1_DAC_24B	DAC Register for Channel 1, Precision Mode.	0x000000	R/W
x3E	DAC_PAGE_24B	DAC Page Register, Precision Mode.	0x000000	R/W
1x41	CH_SELECT_24B	Channel Select for Page Registers, Precision Mode.	0x00	R/W
x42	INPUT_PAGE_24B	Input Page Register, Precision Mode.	0x000000	R/W
)x45	SW_LDAC_24B	Software LDAC Register, Precision Mode.	0x00	W
)x46	CH0_INPUT_24B	Input Register for Channel 0, Precision Mode.	0x000000	R/W
0x49	CH1_INPUT_24B	Input Register for Channel 1, Precision Mode.	0x000000	R/W

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Detailed Register Map

Table 19. Detailed Register Summary

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW		
0x00	INTERFACE_ CONFIG_A	[7:0]	SW_RESET _MSB	RESERVED	ADDR_ DIRECTION	SDO_ ACTIVE		RESERVED		SW_RESET _LSB	0x10	R/W		
0x01	INTERFACE_ CONFIG_B	[7:0]	SINGLE_ INSTRUCTI ON		RESERVED		SHORT_ INSTRUCTI ON		RESERVED		0x08	R/W		
0x02	DEVICE_CONFIG	[7:0]	DEVICE_ STATUS_3	DEVICE_ STATUS_2	DEVICE_ STATUS_1	DEVICE_ STATUS_0	CUSTON	_MODES	OPERATIN	IG_MODES	0x00	R		
0x03	CHIP_TYPE	[7:0]		RESE	RVED			CL	ASS		0x04	R		
0x04	PRODUCT_ID_L	[7:0]				PRODUC	CT_ID[7:0]				0x08	R		
0x05	PRODUCT_ID_H	[7:0]				PRODUC	T_ID[15:8]				0x40	R		
0x06	CHIP_GRADE	[7:0]		DEVICE	_GRADE			DEVICE_	REVISION		0x05	R		
0x0A	SCRATCH_PAD	[7:0]				VA	LUE				0x00	R/W		
0x0B	SPI_REVISION	[7:0]				VER	SION				0x83	R		
0x0C	VENDOR_L	[7:0]				VID	[7:0]				0x56	R		
0x0D	VENDOR_H	[7:0]				VID	[15:8]				0x04	R		
0x0E	STREAM_MODE	[7:0]				LEN	IGTH				0x00	R/W		
0x0F	TRANSFER_ REGISTER	[7:0]	MULTI_I	O_MODE		RESERVED		STREAM_ LENGTH_ KEEP_VALU E	RESERVED		RESERVED		0x00	R/W
0x10	INTERFACE_ CONFIG_C	[7:0]	CRC_E	ENABLE	STRICT_ REGISTER_ ACCESS		RESERVED		CRC_ENABLE_B		0x23	R/W		
0x11	INTERFACE_ STATUS_A	[7:0]	INTERFACE _NOT_ READY	RESERVED	CLOCK_ COUNTING _ERROR	RESERVED	INVALID_ OR_NO_ CRC	WRITE_TO_ READ_ ONLY_ REGISTER	PARTIAL_ REGISTER_ ACCESS	REGISTER_ ADDRESS_ INVALID	0x00	R/W		
0x14	INTERFACE_ CONFIG_D	[7:0]	RESERVED	ALERT_ ENABLE_ PULLUP	RESERVED	MEM_CRC_ EN	SDIO_DRIVE	STRENGTH	DUAL_SPI_ SYNCHRON OUS_EN	SPI_ CONFIG_ DDR	0x04	R/W		
0x15	REFERENCE_ CONFIG	[7:0]	RESERVED	IDUMP_ FASTMODE		RESE	RVED			VOLTAGE_ EL	0x00	R/W		
0x16	ERR_ALARM_ MASK	[7:0]	RESERVED	REF_ RANGE_ ALARM_ MASK	CLOCK_ COUNT_ ERR_ ALARM_ MASK	MEM_CRC_ ERR_ ALARM_ MASK	SPI_CRC_ ERR_ ALARM_ MASK	WRITE_TO_ READ_ ONLY_ALAR M_MASK	PARTIAL_ REGISTER_ ACCESS_ ALARM_ MASK	REGISTER_ ADDRESS_ INVALID_ ALARM_ MASK	0x00	R/W		
0x17	ERR_STATUS	[7:0]	RESERVED	REF_ RANGE_ER R_ STATUS	DUAL_SPI_ STREAM_ EXCEEDS_ DAC_ERR_ STATUS	MEM_CRC_ ERR_ STATUS		RESERVED		RESET_ STATUS	0x01	R/W		
0x18	POWERDOWN_ CONFIG	[7:0]	RESE	RVED	CH1_DAC_ POWERDO WN	CH0_DAC_ POWERDO WN		RESERVED		0x00	R/W			
0x19	CH0_CH1_ OUTPUT_RANGE	[7:0]		CH1_OUTPUT	Γ_RANGE_SEL			CH0_OUTPUT	_RANGE_SEL		0x00	R/W		
0x1B	CH0_OFFSET	[7:0]				CH0_C	FFSET				0x00	R/W		
0x1C	CH0_GAIN	[7:0]	CH0_ RANGE_ OVERRIDE	CH0_GAIN_	SCALING_N		SCALING_P	CH0_ OFFSET_ POLARITY	RESERVED	CH0_ OFFSET[8]	0x00	R/W		

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Table 19. Detailed Register Summary (Continued)

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW
0x1D	CH1_OFFSET	[7:0]				СН	1_OFFSET				0x00	R/W
0x1E	CH1_GAIN	[7:0]	CH1_ RANGE_ OVERRIDE	CH1_GAI	N_SCALING_N	CH1_GA	IN_SCALING_P	CH1_ OFFSET_ POLARITY	RESERVED	CH1_ OFFSET[8]	0x00	R/W
0x28	HW_LDAC_16B	[7:0]			RESE	RVED			HW_LDAC_ MASK_CH1	HW_LDAC_ MASK_CH0	0x00	R/W
0x2A	CH0_DAC_16B	[15:8]				DAC	_DATA0[15:8]				0x00	R/W
0x29		[7:0]				DAC	_DATA0[7:0]				0x00	1
0x2C	CH1_DAC_16B	[15:8]				DAC	_DATA1[15:8]				0x00	R/W
0x2B		[7:0]				DAC	_DATA1[7:0]				0x00	1
0x2E	DAC_PAGE_16B	[15:8]				DAC	_PAGE[15:8]				0x00	R/W
0x2D		[7:0]		DAC_PAGE[7:0]					0x00			
0x2F	CH_SELECT_16B	[7:0]			RESE	RVED			SEL_CH1	SEL_CH0	0x00	R/W
0x31	INPUT_PAGE_	[15:8]					Γ_PAGE[15:8]				0x00	R/W
0x30	16B	[7:0]				INPL	T_PAGE[7:0]				0x00	
0x32	SW_LDAC_16B	[7:0]			RESE	ERVED			SW_LDAC_ CH1	SW_LDAC_ CH0	0x00	W
0x34	CH0_INPUT_16B	[15:8]				INPU	_DATA0[15:8]				0x00	R/W
0x33		[7:0]				INPU	T_DATA0[7:0]				0x00	
0x36	CH1_INPUT_16B	[15:8]				INPU	_DATA1[15:8]				0x00	R/W
0x35		[7:0]				INPU	T_DATA1[7:0]				0x00	
0x37	HW_LDAC_24B	[7:0]			RESE	ERVED			HW_LDAC_ MASK_CH1	HW_LDAC_ MASK_CH0	0x00	R/W
0x3A	CH0_DAC_24B	23:16]					_DATA0[15:8]				0x00	R/W
0x39		[15:8]				DAC	_DATA0[7:0]				0x00	
0x38		[7:0]				R	ESERVED				0x00	
0x3D	CH1_DAC_24B	[23:16]				DAC	_DATA1[15:8]				0x00	R/W
0x3C		[15:8]				DAC	_DATA1[7:0]				0x00	
0x3B		[7:0]					ESERVED				0x00	
0x40	DAC_PAGE_24B	[23:16]					_PAGE[15:8]				0x00	R/W
0x3F		[15:8]					C_PAGE[7:0]				0x00	
0x3E		[7:0]					ESERVED				0x00	
	CH_SELECT_24B	[7:0]			RESE	RVED			SEL_CH1	SEL_CH0	0x00	R/W
	INPUT_PAGE_	[23:16]					T_PAGE[15:8]				0x00	R/W
0x43	24B	[15:8]					T_PAGE[7:0]				0x00	
0x42		[7:0]					ESERVED				0x00	
0x45	SW_LDAC_24B	[7:0]			RESE	ERVED			SW_LDAC_ CH1	SW_LDAC_ CH0	0x00	W
0x48	CH0_INPUT_24B	[23:16]				INPU	_DATA0[15:8]				0x00	R/W
0x47	_	[15:8]					T_DATA0[7:0]				0x00	
0x46		[7:0]					ESERVED				0x00	
0x4B	CH1_INPUT_24B	[23:16]				INPU	_DATA1[15:8]				0x00	R/W
0x4A		[15:8]					T_DATA1[7:0]				0x00	
0x49		[7:0]				R	ESERVED				0x00	

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INTERFACE REGISTER DETAILS

Interface Configuration A Register

Address: 0x00, Reset: 0x10, Name: INTERFACE_CONFIG_A

Interface configuration settings.

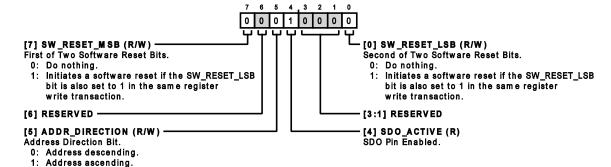


Table 20. Bit Descriptions for INTERFACE_CONFIG_A

Bits	Bit Name	Settings	Description	Reset	Access
7	SW_RESET_MSB	0	First of Two Software Reset Bits. Setting both software reset bits (SW_RESET_MSB and SW_RESET_LSB) in a single SPI write performs a software device reset, returning all registers (except the INTERFACE_CONFIG_A register) to the default power-up state. Do nothing.	0x0	R/W
		1	Initiates a software reset if the SW_RESET_LSB bit is also set to 1 in the same register write transaction.		
6	RESERVED		Reserved.	0x0	R
5	ADDR_DIRECTION	0	Address Direction Bit. Determines sequential addressing behavior when performing register reads and writes on multiple bytes of data in a single data phase. Address descending. Address accessed is automatically decremented by one for each data byte when streaming or addressing multibyte registers. Address ascending. Address accessed is automatically incremented by one for each data byte when streaming or addressing multibyte registers.	0x0	R/W
4	SDO_ACTIVE		SDO Pin Enabled.	0x1	R
[3:1]	RESERVED		Reserved.	0x0	R
0 SW_RESET_LSB		Second of Two Software Reset Bits. Setting both software reset bits (SW_RESET_MSB and SW_RESET_LSB) in a single SPI write performs a software device reset, returning all registers (except the INTERFACE_CONFIG_A register) to the default power-up state.	0x0	R/W	
		0	Do nothing. Initiates a software reset if the SW_RESET_LSB bit is also set to 1 in the same register write transaction.		

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Interface Configuration B Register

Address: 0x01, Reset: 0x08, Name: INTERFACE_CONFIG_B

Additional interface configuration settings.

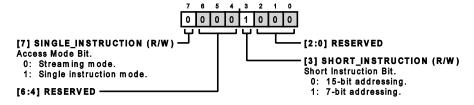


Table 21. Bit Descriptions for INTERFACE CONFIG B

Bits	Bit Name	Settings	Description	Reset	Access
7	SINGLE_INSTRUCTION		Access Mode Bit. Select streaming mode or single instruction mode.	0x0	R/W
			O Streaming mode. The address increments/decrements as successive data bytes are received according to the ADDR_DIRECTION bit setting in the INTERFACE_CONFIG_A register and the LENGTH bits setting in the STREAM_MODE register.		
			1 Single instruction mode.		
[6:4]	RESERVED		Reserved.	0x0	R
3	SHORT_INSTRUCTION		Short Instruction Bit. Sets the length of the address in the instruction phase to 7 bits or 15 bits.	0x1	R/W
			0 15-bit addressing.		
			1 7-bit addressing.		
[2:0]	RESERVED		Reserved.	0x0	R

Device Configuration Register

Address: 0x02, Reset: 0x00, Name: DEVICE_CONFIG

This register is intended for compatibility with the standardized register map and it has no effect on this device.

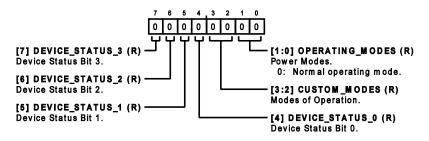


Table 22. Bit Descriptions for DEVICE_CONFIG

Bits	Bit Name	Settings	Description	Reset	Access
7	DEVICE_STATUS_3		Device Status Bit 3.	0x0	R
6	DEVICE_STATUS_2		Device Status Bit 2.	0x0	R
5	DEVICE_STATUS_1		Device Status Bit 1.	0x0	R
4	DEVICE_STATUS_0		Device Status Bit 0.	0x0	R
[3:2]	CUSTOM_MODES		Modes of Operation.	0x0	R
[1:0]	OPERATING_MODES		Power Modes.	0x0	R
		0	Normal operating mode.		

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Chip Type Register

Address: 0x03, Reset: 0x04, Name: CHIP_TYPE

The chip type register contains the identifier of the precision DAC family, which includes the AD3552R. This register must be used in conjunction with the product ID to uniquely identify the AD3552R.

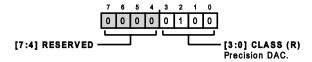


Table 23. Bit Descriptions for CHIP_TYPE

Bits	Bit Name	Settings	DescriptionResReserved.0x0		Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	CLASS		Precision DAC.	0x4	R

Product ID Low Register

Address: 0x04, Reset: 0x08, Name: PRODUCT_ID_L

Low byte of the product ID.

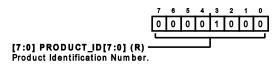


Table 24. Bit Descriptions for PRODUCT_ID_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	PRODUCT_ID[7:0]		Product Identification Number.	0x8	R

Product ID High Register

Address: 0x05, Reset: 0x40, Name: PRODUCT_ID_H

High byte of the product ID.

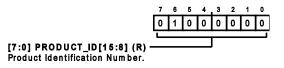


Table 25. Bit Descriptions for PRODUCT ID H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	PRODUCT_ID[15:8]		Product Identification Number.	0x40	R

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Chip Grade Register

Address: 0x06, Reset: 0x05, Name: CHIP_GRADE

Identifies product variations and device revisions. The device revision refers to the version of the silicon and the device grade refers to the version of the test procedure.

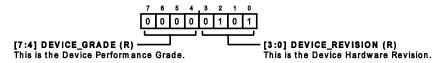


Table 26. Bit Descriptions for CHIP GRADE

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	DEVICE_GRADE		This is the Device Performance Grade.	0x0	R
[3:0]	DEVICE_REVISION		This is the Device Hardware Revision.	0x5	R

Scratch Pad Register

Address: 0x0A, Reset: 0x00, Name: SCRATCH_PAD

This register has no functional purpose. It is provided to test write and read operations.

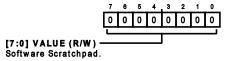


Table 27. Bit Descriptions for SCRATCH_PAD

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	VALUE		Software Scratchpad.	0x0	R/W

SPI Revision Register

Address: 0x0B, Reset: 0x83, Name: SPI_REVISION

Indicates the SPI interface revision.

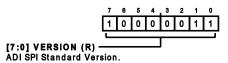


Table 28. Bit Descriptions for SPI_REVISION

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	VERSION		ADI SPI Standard Version.	0x83	R

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Vendor ID Low Register

Address: 0x0C, Reset: 0x56, Name: VENDOR_L

Low byte of the vendor ID.

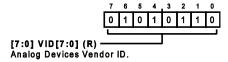


Table 29. Bit Descriptions for VENDOR_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	VID[7:0]		Analog Devices Vendor ID.	0x56	R

Vendor ID High Register

Address: 0x0D, Reset: 0x04, Name: VENDOR_H

High byte of the vendor ID.

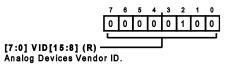


Table 30. Bit Descriptions for VENDOR_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	VID[15:8]		Analog Devices Vendor ID.	0x4	R

Stream Mode Register

Address: 0x0E, Reset: 0x00, Name: STREAM_MODE

Defines the length of the loop when streaming data.

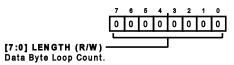


Table 31. Bit Descriptions for STREAM MODE

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	LENGTH		Data Byte Loop Count. Specifies the data byte count before looping back to the start address. Only valid in streaming mode. A nonzero value sets the number of data bytes written or read before the address loops back to the start address. A maximum of 255 bytes can be transmitted using this approach. A value of 0x00 disables the loopback so that addressing wraps around at the upper and lower limits of memory.	0x0	R/W

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Transfer Configuration Register

Address: 0x0F, Reset: 0x00, Name: TRANSFER_REGISTER

This register configures the SPI mode used to transfer data and enables looping over the same register section when streaming data.

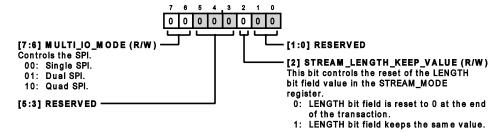


Table 32. Bit Descriptions for TRANSFER REGISTER

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	MULTI_IO_MODE		Controls the SPI.	0x0	R/W
		00	Single SPI.		
		01	Dual SPI.		
		10	Quad SPI.		
[5:3]	RESERVED		Reserved.	0x0	R
2	STREAM_LENGTH_KEEP_VALUE		This bit controls the reset of the LENGTH bit field value in the STREAM_MODE register.	0x0	R/W
		0	LENGTH bit field is reset to 0 at the end of the transaction.		
		1	LENGTH bit field keeps the same value.		
[1:0]	RESERVED		Reserved.	0x0	R

Interface Configuration C Register

Address: 0x10, Reset: 0x23, Name: INTERFACE_CONFIG_C

Additional interface configuration settings.

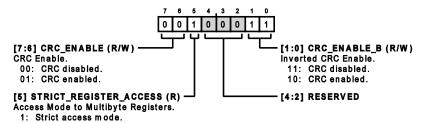


Table 33. Bit Descriptions for INTERFACE_CONFIG_C

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	CRC_ENABLE	200	CRC Enable. This field is written to enable/disable the use of the CRC error detection on the interface (when the device is in register mode). The CRC_ENABLE_B bits must also be written with the inverted value of the CRC_ENABLE bits in the same SPI write transaction for the CRC status to be changed.	0x0	R/W
		00	CRC disabled.		
		01	CRC enabled.		
5	STRICT_REGISTER_ACCESS		Access Mode to Multibyte Registers. This bit is read only. Register write transactions to multibyte registers must include data for	0x1	R

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Table 33. Bit Descriptions for INTERFACE CONFIG C (Continued)

Bits	Bit Name	Settings	Description	Reset	Access
			each of its individual bytes for the register to be updated. Failure to write data to the entire multibyte register (entity) results in the register contents not being updated in memory, and the PARTIAL_REGISTER_ACCESS flag in the INTERFACE_STATUS_A register being set.		
		1	Strict access mode. Multibyte registers require all bytes to be read/written in full to avoid the PARTIAL_REGISTER_ACCESS bit being flagged.		
[4:2]	RESERVED		Reserved.	0x0	R
[1:0]	CRC_ENABLE_B		Inverted CRC Enable. This field must be written with the complementary value of the CRC_ENABLE field.	0x3	R/W
		11	CRC disabled.		
		10	CRC enabled.		

Interface Status A Register

Address: 0x11, Reset: 0x00, Name: INTERFACE_STATUS_A

This register flags several error conditions related to SPI communication and register addressing.

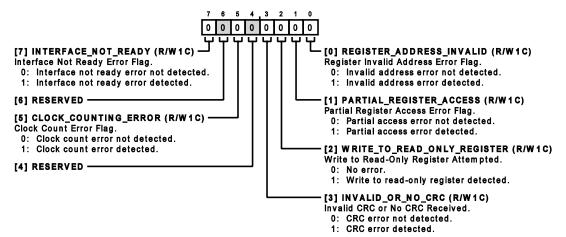


Table 34. Bit Descriptions for INTERFACE STATUS A

Bits	Bit Name	Settings	Description	Reset	Access
7	INTERFACE_NOT_READY		Interface Not Ready Error Flag. Indicates if the device interface was not ready for a transaction when an SPI read or write transaction was requested by the digital host (master). This flag bit is set if an SPI frame begins before the device is ready after a power-on reset. This error flag is write-1-to-clear (when this error flag is set, it can only be reset by writing a 1 to this bit).	0x0	R/W1C
		0	Interface not ready error not detected.		
		1	Interface not ready error detected.		
3	RESERVED		Reserved.	0x0	R
5	CLOCK_COUNTING_ERROR		Clock Count Error Flag. Indicates if the incorrect number of serial clock edges was detected in an SPI read or write transaction (for example, if the transaction was terminated in the middle of a byte). This error flag is write-1-to-clear	0x0	R/W1C

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Table 34. Bit Descriptions for INTERFACE_STATUS_A (Continued)

Bits	Bit Name	Settings	Description	Reset	Access
			(when this error flag is set, it can only be reset by writing a 1 to this bit).		
		0	Clock count error not detected.		
		1	Clock count error detected.		
	RESERVED		Reserved.	0x0	R
3	INVALID_OR_NO_CRC		Invalid CRC or No CRC Received. This is set when the master fails to send a CRC or when the device calculates and checks the CRC and finds its value is incorrect. This error flag is write-1-to-clear (when this error flag is set, it can only be reset by writing a 1 to this bit).	0x0	R/W1C
		0	CRC error not detected.		
		1	CRC error detected.		
2	WRITE_TO_READ_ONLY_REGISTER		Write to Read-Only Register Attempted. This bit indicates if the digital host attempts an SPI write to a register that contains exclusively read only fields. This error flag is write-1-to-clear (when this error flag is set, it can only be reset by writing a 1 to this bit).	0x0	R/W1C
		0	No error.		
		1	Write to read-only register detected.		
I	PARTIAL_REGISTER_ACCESS		Partial Register Access Error Flag. This bit is asserted when there are not enough bytes of data in a transaction addressed to a multibyte register. This error flag is write-1-to-clear (when this error flag is set, it can only be reset by writing a 1 to this bit).	0x0	R/W1C
		0	Partial access error not detected.		
		1	Partial access error detected.		
0	REGISTER_ADDRESS_INVALID		Register Invalid Address Error Flag. Indicates if an SPI read or write transaction was attempted on an invalid register address. This error flag is write-1-to-clear (when this error flag is set, it can only be reset by writing a 1 to this bit).	0x0	R/W1C
		0	Invalid address error not detected.		
		1	Invalid address error detected.		

Interface Configuration D Register

Address: 0x14, Reset: 0x04, Name: INTERFACE_CONFIG_D

This register contains miscellaneous configuration bits affecting SPI communication and electrical parameters of digital signals.

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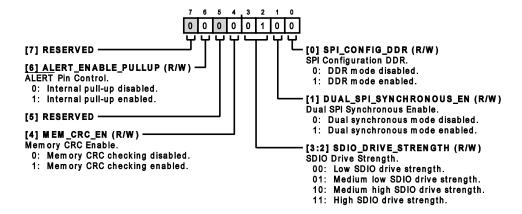


Table 35. Bit Descriptions for INTERFACE_CONFIG_D

Bits	Bit Name	Settings	Description	Reset	Access
7	RESERVED		Reserved.	0x0	R
6	ALERT_ENABLE_PULLUP		ALERT Pin Control. Enable internal 2.5 kΩ pull-up resistor.	0x0	R/W
		0	Internal pull-up disabled. An external pull-up is required.		
		1	Internal pull-up enabled.		
5	RESERVED		Reserved.	0x0	R
4	MEM_CRC_EN		Memory CRC Enable. This bit controls the continuous	0x0	R/W
			checking of the primary register set and the ROM memory.		
		0	Memory CRC checking disabled.		
		1	Memory CRC checking enabled.		
[3:2]	SDIO_DRIVE_STRENGTH		SDIO Drive Strength. These two bits allow for the increase in	0x1	R/W
			SDIO drive strength.		
		00	Low SDIO drive strength.		
		01	Medium low SDIO drive strength.		
		10	Medium high SDIO drive strength.		
		11	High SDIO drive strength.		
1	DUAL_SPI_SYNCHRONOUS_EN		Dual SPI Synchronous Enable. This bit controls the dual	0x0	R/W
			synchronous data transfer using one SDIO line for each DAC		
			stream.		
		0	Dual synchronous mode disabled.		
		1	Dual synchronous mode enabled.		
0	SPI_CONFIG_DDR		SPI Configuration DDR. This bit controls the use of DDR for	0x0	R/W
			data transfers.		
		0	DDR mode disabled.		
		1	DDR mode enabled.		

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DAC REGISTER DETAILS

Reference Configuration Register

Address: 0x15, Reset: 0x00, Name: REFERENCE_CONFIG

This register controls the source and driving of the voltage reference.

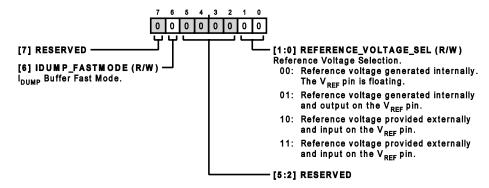


Table 36. Bit Descriptions for REFERENCE CONFIG

Bits	Bit Name	Settings	Description	Reset	Access
7	RESERVED		Reserved.	0x0	R
6	IDUMP_FASTMODE		I _{DUMP} Buffer Fast Mode. Set this bit to increase the I _{DD} of the I _{DUMP} buffer of the amplifier to allow for a greater gain bandwidth.	0x0	R/W
[5:2]	RESERVED		Reserved.	0x0	R
[1:0]	REFERENCE_VOLTAGE_SEL		Reference Voltage Selection. These two bits are used to select the configuration of the reference voltage circuit.	0x0	R/W
		00	Reference voltage generated internally. The V _{REF} pin is floating.		
		01	Reference voltage generated internally and output on the V _{REF} pin.		
		10	Reference voltage provided externally and input on the V _{REF} pin.		
		11	Reference voltage provided externally and input on the V _{REF} pin.		

Error Alarm Mask Register

Address: 0x16, Reset: 0x00, Name: ERR_ALARM_MASK

This register selects which error conditions cause the assertion of the ALERT pin.

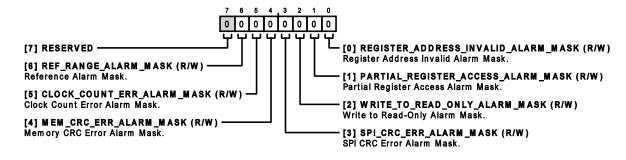


Table 37. Bit Descriptions for ERR_ALARM_MASK

Bits	Bit Name	Settings	Description	Reset	Access
7	RESERVED		Reserved.	0x0	R

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Table 37. Bit Descriptions for ERR ALARM MASK (Continued)

Bits	Bit Name	Settings	Description	Reset	Access
6	REF_RANGE_ALARM_MASK		Reference Alarm Mask. When set, the user can ignore alarms due to the reference dipping below 2 V.	0x0	R/W
5	CLOCK_COUNT_ERR_ALARM_MASK		Clock Count Error Alarm Mask. When set, the user can ignore alarms due to an insufficient number of clock periods for a user write.	0x0	R/W
4	MEM_CRC_ERR_ALARM_MASK		Memory CRC Error Alarm Mask. When set, the user can ignore alarms due to a memory CRC error.	0x0	R/W
3	SPI_CRC_ERR_ALARM_MASK		SPI CRC Error Alarm Mask. When set, the user can ignore alarms due to the SPI CRC checker.	0x0	R/W
2	WRITE_TO_READ_ONLY_ALARM_MASK		Write to Read-Only Alarm Mask. When set, the user can ignore alarms due to the user writing to a read-only register.	0x0	R/W
1	PARTIAL_REGISTER_ACCESS_ALARM_MASK		Partial Register Access Alarm Mask. When set, the user can ignore alarms due to the user not completing the write to a register.	0x0	R/W
0	REGISTER_ADDRESS_INVALID_ALARM_MASK		Register Address Invalid Alarm Mask. When set, the user can ignore alarms due to the user writing to an invalid register address.	0x0	R/W

Error Status Register

Address: 0x17, Reset: 0x01, Name: ERR_STATUS

This register signals a combination of errors in the analog and digital domains. All the bits are sticky and can be cleared by writing 1.

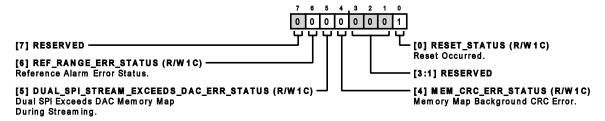


Table 38. Bit Descriptions for ERR_STATUS

Bits	Bit Name	Settings	Description	Reset	Access
7	RESERVED		Reserved.	0x0	R
6	REF_RANGE_ERR_STATUS		Reference Alarm Error Status. This bit indicates an alarm if the reference dips below 2 V.	0x0	R/W1C
5	DUAL_SPI_STREAM_EXCEEDS_DAC_ERR_STATUS		Dual SPI Exceeds DAC Memory Map During Streaming. This bit indicates an alarm when in dual SPI and streaming access goes beyond the DAC memory map.	0x0	R/W1C
4	MEM_CRC_ERR_STATUS		Memory Map Background CRC Error. This bit indicates an alarm when the background CRC detects	0x0	R/W1C

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Table 38. Bit Descriptions for ERR STATUS (Continued)

Bits	Bit Name	Settings	Description	Reset	Access
			bit corruption within the memory		
			map.		
[3:1]	RESERVED		Reserved.	0x0	R
0	RESET_STATUS		Reset Occurred. This bit indicates that the device has just completed initialization following a reset. This bit asserts the ALERT pin and it is nonmaskable. Therefore, it must be cleared right after initialization.	0x1	R/W1C

Power-Down Configuration Register

Address: 0x18, Reset: 0x00, Name: POWERDOWN_CONFIG

This register controls the individual power-down of the DAC channels.

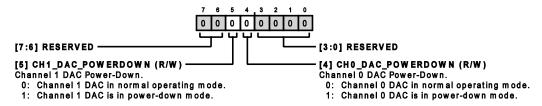


Table 39. Bit Descriptions for POWERDOWN CONFIG

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	RESERVED		Reserved.	0x0	R
5	CH1_DAC_POWERDOWN		Channel 1 DAC Power-Down.	0x0	R/W
		0	Channel 1 DAC in normal operating mode.		
		1	Channel 1 DAC is in power-down mode.		
4	CH0_DAC_POWERDOWN		Channel 0 DAC Power-Down.	0x0	R/W
		0	Channel 0 DAC in normal operating mode.		
		1	Channel 0 DAC is in power-down mode.		
[3:0]	RESERVED		Reserved.	0x0	R

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Output Range Register

Address: 0x19, Reset: 0x00, Name: CH0_CH1_OUTPUT_RANGE

This register sets the output range of the DAC channels to one of the preconfigured ranges listed in Table 8. In addition to setting this register, the corresponding RFBx y resistor must be connected to obtain the expected result.

7 6 5 4 3 2 1 0

[7:4] CH1_OUTPUT_RANGE_SEL (R/W) Channel 1 Output Range Select.

000: 0 V to 2.5 V range. 001: 0 V to 5 V range. 010: 0 V to 10 V range. 011: -5 V to +5 V range. 100: -10 V to +10 V range. [3:0] CH0_OUTPUT_RANGE_SEL (R/W)
Channel 0 Output Range Select.

000: 0 V to 2.5 V range. 001: 0 V to 5 V range. 010: 0 V to 10 V range. 011: -5 V to +5 V range. 100: -10 V to +10 V range.

Table 40. Bit Descriptions for CH0 CH1 OUTPUT RANGE

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	CH1_OUTPUT_RANGE_SEL		Channel 1 Output Range Select. The user can select which voltage output range is desired.	0x0	R/W
		000	0 V to 2.5 V range. Requires RFB1_1 connection.		
		001	0 V to 5 V range. Requires RFB1_1 connection.		
		010	0 V to 10 V range. Requires RFB2_1 connection.		
		011	-5 V to +5 V range. Requires RFB2_1 connection.		
		100	−10 V to +10 V range. Requires RFB4_1 connection.		
3:0]	CH0_OUTPUT_RANGE_SEL		Channel 0 Output Range Select. The user can select which voltage output range is desired.	0x0	R/W
		000	0 V to 2.5 V range. Requires RFB1_0 connection.		
		001	0 V to 5 V range. Requires RFB1_0 connection.		
		010	0 V to 10 V range. Requires RFB2_0 connection.		
		011	-5 V to +5 V range. Requires RFB2_0 connection.		
		100	−10 V to +10 V range. Requires RFB4_0 connection.		

Channel 0 Offset Register

Address: 0x1B, Reset: 0x00, Name: CH0_OFFSET

This register configures the dc offset of the Channel 0 DAC. For this value to take effect, the CH0_RANGE_OVERRIDE bit must be set in the CH0_GAIN register.

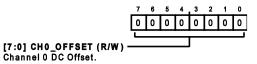


Table 41. Bit Descriptions for CH0 OFFSET

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	CH0_OFFSET		Channel 0 DC Offset.	0x0	R/W

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Channel 0 Gain Register

Address: 0x1C, Reset: 0x00, Name: CH0_GAIN

This register enables the configuration of custom span modes, configures the scaling of the PMOS DAC and NMOS DAC current sources, and controls the polarity of the offset value.

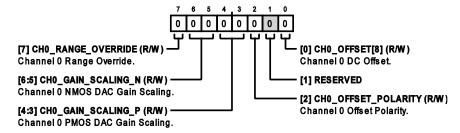


Table 42. Bit Descriptions for CH0 GAIN

Bits	Bit Name	Description	Reset	Access
7	CH0_RANGE_OVERRIDE	Channel 0 Range Override. This bit allows the user to override the preconfigured range settings		
		and manually set offset and gain.	0x0	R/W
		0: Use preconfigured range settings.		
		1: Use custom range settings.		
[6:5]	CH0_GAIN_SCALING_N	Channel 0 NMOS DAC Gain Scaling. This field controls the multiplying factor for the codes applied to the NMOS DAC current sources.	0x0	R/W
		00: Gain scaling 1.		
		01: Gain scaling 0.5.		
		10: Gain scaling 0.25.		
		11: Gain scaling 0.125.		
[4:3]	CH0_GAIN_SCALING_P	Channel 0 PMOS DAC Gain Scaling. This field controls the multiplying factor for the codes applied to the PMOS DAC current sources.	0x0	R/W
		00: Gain scaling 1.		
		01: Gain scaling 0.5.		
		10: Gain scaling 0.25.		
		11: Gain scaling 0.125.		
2	CH0_OFFSET_POLARITY	Channel 0 Offset Polarity. This bit sets the polarity of the offset.	0x0	R/W
		0: Positive offset.		
		1: Negative offset.		
1	RESERVED	Reserved.	0x0	R
0	CH0 OFFSET[8]	Channel 0 DC Offset.	0x0	R/W

Channel 1 Offset Register

Address: 0x1D, Reset: 0x00, Name: CH1_OFFSET

This register configures the dc offset of the Channel 0 DAC. For this value to take effect, the CH1_RANGE_OVERRIDE bit must be set in the CH1_GAIN register.

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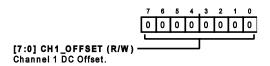


Table 43. Bit Descriptions for CH1_OFFSET

Bits	Bit Name	Settings	Description		Access
[7:0]	CH1_OFFSET		Channel 1 DC Offset.	0x0	R/W

Channel 1 Gain Register

Address: 0x1E, Reset: 0x00, Name: CH1_GAIN

This register enables the configuration of custom span modes, configures the scaling of the PMOS DAC and NMOS DAC current sources, and controls the polarity of the offset value.

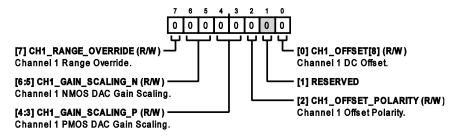


Table 44. Bit Descriptions for CH1_GAIN

Bits	Bit Name	Description	Reset	Access
7	CH1_RANGE_OVERRIDE	Channel 1 Range Override. This bit allows the user to override the preconfigured range settings and manually set offset and gain.	0x0	R/W
		0: Use preconfigured range settings.		
		1: Use custom range settings.		
[6:5]	CH1_GAIN_SCALING_N	Channel 1 NMOS DAC Gain Scaling. This field controls the multiplying factor for the codes applied to the NMOS DAC current sources.	0x0	R/W
		00: Gain scaling 1.		
		01: Gain scaling 0.5.		
		10: Gain scaling 0.25.		
		11: Gain scaling 0.125.		
[4:3]	CH1_GAIN_SCALING_P	Channel 1 PMOS DAC Gain Scaling. This field controls the multiplying factor for the codes applied to the PMOS DAC current sources.	0x0	R/W
		00: Gain scaling 1.		
		01: Gain scaling 0.5.		
		10: Gain scaling 0.25.		
		11: Gain scaling 0.125.		
2	CH1_OFFSET_POLARITY	Channel 1 Offset Polarity. This bit sets the polarity of the offset.	0x0	R/W
		0: Positive offset.		
		1: Negative offset.		
1	RESERVED	Reserved.	0x0	R
0	CH1 OFFSET[8]	Channel 1 DC Offset.	0x0	R/W

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Hardware LDAC Mask Register, Fast Mode

Address: 0x28, Reset: 0x00, Name: HW_LDAC_16B

This register controls the masking of the external LDAC signal to latch data into each of the DAC channels.

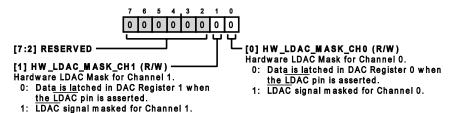


Table 45. Bit Descriptions for HW LDAC 16B

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
1	HW_LDAC_MASK_CH1		Hardware LDAC Mask for Channel 1. This bit controls the latching of data into the DAC register when the LDAC signal is asserted.	0x0	R/W
		0	Data is latched in DAC Register 1 when the LDAC pin is asserted.		
		1	LDAC signal masked for Channel 1. DAC register is not updated when LDAC is asserted.		
0	HW_LDAC_MASK_CH0		Hardware LDAC Mask for Channel 0. This bit controls the latching of data into the DAC register when the LDAC signal is asserted.	0x0	R/W
		0	Data is latched in DAC Register 0 when the LDAC pin is asserted.		
		1	LDAC signal masked for Channel 0. DAC register is not updated when LDAC is asserted.		

DAC Register for Channel 0, Fast Mode

Address: 0x29, Reset: 0x0000, Name: CH0_DAC_16B

This register contains the data currently played on DAC Channel 0.

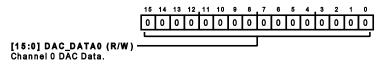


Table 46. Bit Descriptions for CH0 DAC 16B

Bits	Bit Name	Settings	escription R		Access
[15:0]	DAC_DATA0		Channel 0 DAC Data.	0x0	R/W

DAC Register for Channel 1, Fast Mode

Address: 0x2B, Reset: 0x0000, Name: CH1_DAC_16B

This register contains the data currently played on DAC Channel 1.

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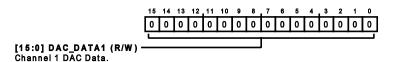


Table 47. Bit Descriptions for CH1 DAC 16B

Bits	Bit Name	Settings	Description F		Access
[15:0]	DAC_DATA1		Channel 1 DAC Data.	0x0	R/W

DAC Page Register, Fast Mode

Address: 0x2D, Reset: 0x0000, Name: DAC_PAGE_16B

This register is used to write data to one or both channels according to the configuration of the SEL_CHx bits in the CH_SELECT_16B register. It can be used to write both channels simultaneously without using the LDAC signal.

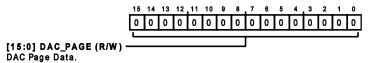


Table 48. Bit Descriptions for DAC_PAGE_16B

Bits	Bit Name	Settings	Description I		Access
[15:0]	DAC_PAGE		DAC Page Data. Following a write to this register, the DAC code loaded into this register is copied into the DAC register of any channels selected in the CH_SELECT_16B register.	0x0	R/W

Channel Select for Page Registers, Fast Mode

Address: 0x2F, Reset: 0x00, Name: CH_SELECT_16B

This register selects which channel registers are updated following a write to the DAC PAGE 16B or INPUT PAGE 16B registers.

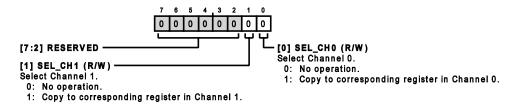


Table 49. Bit Descriptions for CH SELECT 16B

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
1	SEL_CH1		Select Channel 1. When this bit is set, data written to the INPUT_PAGE_16B register is copied to the CH1_INPUT_16B register and data written to the DAC_PAGE_16B register is copied to the CH1_DAC_16B register.	0x0	R/W
		0	No operation.		
		1	Copy to corresponding register in Channel 1.		
0	SEL_CH0		Select Channel 0. When this bit is set, data written to the INPUT_PAGE_16B register is copied to the CH0_INPUT_16B register and data written to the DAC_PAGE_16B register is copied to the CH0_DAC_16B register.	0x0	R/W
		0	No operation.		
		1	Copy to corresponding register in Channel 0.		

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Input Page Register, Fast Mode

Address: 0x30, Reset: 0x0000, Name: INPUT_PAGE_16B

This register is used to write data to one or both DAC input registers according to the configuration of the SEL_CHx bits in the CH_SE-LECT_16B register.

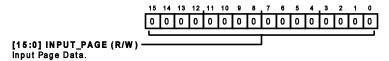


Table 50. Bit Descriptions for INPUT PAGE 16B

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	INPUT_PAGE		Input Page Data. Following a write to this register, the DAC code loaded into this register is copied into the input register of any channels selected in the CH_SELECT_16B register.	0x0	R/W

Software LDAC Register, Fast Mode

Address: 0x32, Reset: 0x00, Name: SW_LDAC_16B

This register is used to trigger a data transfer between the input registers and the DAC registers. It is the software equivalent of pulsing the LDAC line low.

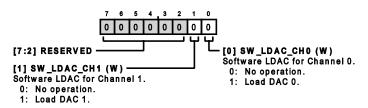


Table 51. Bit Descriptions for SW_LDAC_16B

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
1	SW_LDAC_CH1		Software LDAC for Channel 1. Setting this bit transfers contents from the CH1_INPUT_16B register to the CH1_DAC_16B register. This bit automatically resets after being written.	0x0	W
		0	No operation.		
		1	Load DAC 1.		
0	SW_LDAC_CH0		Software LDAC for Channel 0. Setting this bit transfers contents from the CH0_INPUT_16B register to the CH0_DAC_16B register. This bit automatically resets after being written.	0x0	W
		0	No operation.		
		1	Load DAC 0.		

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Input Register for Channel 0, Fast Mode

Address: 0x33, Reset: 0x0000, Name: CH0_INPUT_16B

This register contains the data to be transferred to the DAC register using one of the various trigger options, hardware LDAC, software LDAC, or automatic transfer.

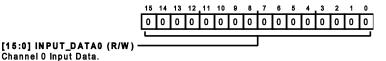


Table 52. Bit Descriptions for CH0 INPUT 16B

Bits	Bit Name	Settings	Description F		Access
[15:0]	INPUT_DATA0		Channel 0 Input Data.	0x0	R/W

Input Register for Channel 1, Fast Mode

Address: 0x35, Reset: 0x0000, Name: CH1_INPUT_16B

This register contains the data to be transferred to the DAC register using one of the various trigger options, hardware LDAC, software LDAC, or automatic transfer.

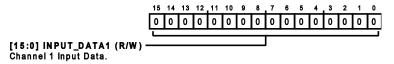


Table 53. Bit Descriptions for CH1 INPUT 16B

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	INPUT_DATA1		Channel 1 Input Data.	0x0	R/W

Hardware LDAC Mask Register, Precision Mode

Address: 0x37, Reset: 0x00, Name: HW_LDAC_24B

This register controls the masking of the external LDAC signal to latch data into each of the DAC channels.

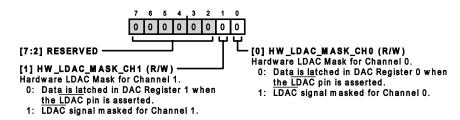


Table 54. Bit Descriptions for HW_LDAC_24B

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
1	HW_LDAC_MASK_CH1		Hardware LDAC Mask for Channel 1. This bit controls the latching of data into the DAC register when the LDAC signal is asserted.	0x0	R/W
		0	Data is latched in DAC Register 1 when the LDAC pin is asserted.		
		1	LDAC signal masked for Channel 1. DAC register is not updated when LDAC is asserted.		
0	HW_LDAC_MASK_CH0		Hardware LDAC Mask for Channel 0. This bit controls the latching of data into the DAC register when the LDAC signal is asserted.	0x0	R/W

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Table 54. Bit Descriptions for HW LDAC 24B (Continued)

Bits	Bit Name	Settings	Description	Reset	Access
			Data is latched in DAC Register 0 when the LDAC pin is asserted. LDAC signal masked for Channel 0. DAC register is not updated when		
		'	LDAC is asserted.		

DAC Register for Channel 0, Precision Mode

Address: 0x38, Reset: 0x000000, Name: CH0_DAC_24B

This register contains the data currently played on DAC Channel 0.

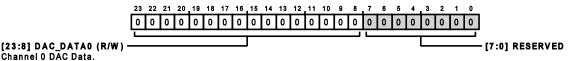


Table 55. Bit Descriptions for CH0 DAC 24B

Bits	Bit Name	Settings	Description F		Access
[23:8]	DAC_DATA0		Channel 0 DAC Data.	0x0	R/W
[7:0]	RESERVED		Reserved.	0x0	R

DAC Register for Channel 1, Precision Mode

Address: 0x3B, Reset: 0x000000, Name: CH1_DAC_24B

This register contains the data currently played on DAC Channel 1.

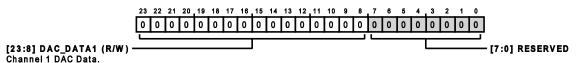


Table 56. Bit Descriptions for CH1 DAC 24B

Bits	Bit Name	Settings	escription F		Access
[23:8]	DAC_DATA1		Channel 1 DAC Data.	0x0	R/W
[7:0]	RESERVED		Reserved.	0x0	R

DAC Page Register, Precision Mode

Address: 0x3E, Reset: 0x000000, Name: DAC_PAGE_24B

This register is used to write data to one or both channels according to the configuration of the SEL_CHx bits in the CH_SELECT_24B register. It can be used to write both channels simultaneously without using the LDAC signal.



Table 57. Bit Descriptions for DAC_PAGE_24B

Bits	Bit Name	Settings	Description	Reset	Access
[23:8]	DAC_PAGE		DAC Page Data. Following a write to this register, the DAC code loaded into this register is copied into the DAC register of any channels selected in the CH_SELECT_24B register.	0x0	R/W
[7:0]	RESERVED		Reserved.	0x0	R

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Channel Select for Page Registers, Precision Mode

Address: 0x41, Reset: 0x00, Name: CH_SELECT_24B

This register selects which channel registers are updated following a write to the DAC PAGE 24B or INPUT PAGE 24B registers.

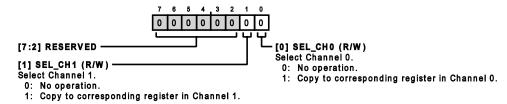


Table 58. Bit Descriptions for CH SELECT 24B

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
1	SEL_CH1		Select Channel 1. When this bit is set, data written to the INPUT_PAGE_24B register is copied to the CH1_INPUT_24B register and data written to the DAC_PAGE_24B register is copied to the CH1_DAC_24B register.	0x0	R/W
		0	No operation.		
		1	Copy to corresponding register in Channel 1.		
0	SEL_CH0		Select Channel 0. When this bit is set, data written to the INPUT_PAGE_24B register is copied to the CH0_INPUT_24B register and data written to the DAC_PAGE_24B register is copied to the CH0_DAC_24B register.	0x0	R/W
		0	No operation.		
		1	Copy to corresponding register in Channel 0.		

Input Page Register, Precision Mode

Address: 0x42, Reset: 0x000000, Name: INPUT_PAGE_24B

This register is used to write data to one or both DAC input registers according to the configuration of the SEL_CHx bits in the CH_SE-LECT 24B register.

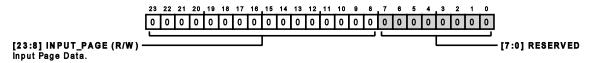


Table 59. Bit Descriptions for INPUT_PAGE_24B

Bits	Bit Name	Settings	Description	Reset	Access
[23:8]	INPUT_PAGE		Input Page Data. Following a write to this register, the DAC code loaded into this register is copied into the input register of any channels selected in the CH_SELECT_24B register.	0x0	R/W
[7:0]	RESERVED		Reserved.	0x0	R

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Software LDAC Register, Precision Mode

Address: 0x45, Reset: 0x00, Name: SW_LDAC_24B

This register is used to trigger a data transfer between the input registers and the DAC registers. It is the software equivalent of pulsing the LDAC line low.

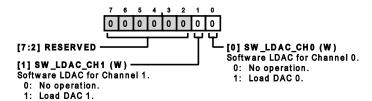


Table 60. Bit Descriptions for SW_LDAC_24B

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
1	SW_LDAC_CH1		Software LDAC for Channel 1. Setting this bit transfers contents from the CH1_INPUT_24B register to the CH1_DAC_24B register. This bit automatically resets after being written.	0x0	W
		0	No operation.		
		1	Load DAC 1.		
0	SW_LDAC_CH0		Software LDAC for Channel 0. Setting this bit transfers contents from the CH0_INPUT_24B register to the CH0_DAC_24B register. This bit automatically resets after being written.	0x0	W
		0	No operation.		
		1	Load DAC 0.		

Input Register for Channel 0, Precision Mode

Address: 0x46, Reset: 0x000000, Name: CH0 INPUT 24B

This register contains the data to be transferred to the DAC register using one of the various trigger options, hardware LDAC, software LDAC, or automatic transfer.

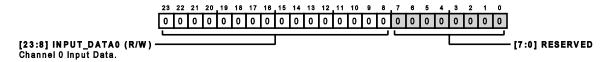


Table 61. Bit Descriptions for CH0_INPUT_24B

Bits	Bit Name	Settings	Description	Reset	Access
[23:8]	INPUT_DATA0		Channel 0 Input Data.	0x0	R/W
[7:0]	RESERVED		Reserved.	0x0	R

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Input Register for Channel 1, Precision Mode

Address: 0x49, Reset: 0x000000, Name: CH1_INPUT_24B

This register contains the data to be transferred to the DAC register using one of the various trigger options, hardware LDAC, software LDAC, or automatic transfer.

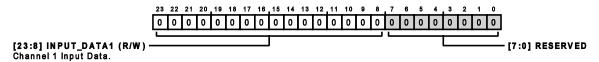


Table 62. Bit Descriptions for CH1 INPUT 24B

Bits	Bit Name	Settings	Description	Reset	Access
[23:8]	INPUT_DATA1		Channel 1 Input Data.	0x0	R/W
[7:0]	RESERVED		Reserved.	0x0	R

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POWER SUPPLY RECOMMENDATIONS

The AD3552R does not have any restriction for power supply sequencing. The chip incorporates a power monitor for AV_{DD} and DV_{DD} that releases the internal reset when both rails are within specification. Nevertheless, the recommended sequence to turn on the supply rails is GND, AV_{DD} , DV_{DD} , V_{LOGIC} because it minimizes the power-up glitch.

It is recommended to connect AGND and DGND together and have a single solid ground plane. The exposed pad under the chip must also be connected to the ground plane.

AV_{DD} has a constant power consumption that is independent of the update rate. The main caution for this rail is ensuring that noise level is low in the high frequencies, where AC PSRR is lower.

 $\rm DV_{DD}$ has a variable power consumption that depends on the update rate and the SPI bus mode. Dynamic current has fast variations that cause the rail to be noisy. If $\rm DV_{DD}$ is derived from AV_DD, a filter is recommended in addition to the LDO to completely remove the effect on the DAC output.

V_{LOGIC} has very low current demand that depends on the SPI bus mode and clock rate. Power consumption is maximum in readout operations in guad SPI mode.

The recommended decoupling for the supply rails and the analog lines is shown in Figure 94.

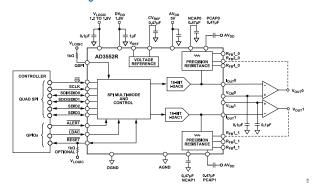


Figure 94. Recommended Application Circuit

The decoupling capacitors on PCAPx, NCAPx, V_{CM}x, and CV_{REF} can be adjusted to achieve the desired trade-off between noise corner frequency and power-up glitch amplitude.

Use capacitors with NP0 dielectric for the NCAPx and PCAPx feedback capacitors and any other capacitors on the path of the output voltage to avoid the derating caused by low frequency voltage variations. The decoupling capacitors for the supply rails, V_{CM} and $CV_{REF},$ can use materials with high dielectric constant because the voltage on these lines is constant.

COMBINING DAC CHANNELS

The AD3552R allows for combining of the two DAC channels to produce a single output. This results in lower noise density and faster settling time with higher power consumption.

To implement this configuration, both $I_{OUT}x$ pins must be connected together and the same $R_{FB}x_y$ pins from both DACs must be connected together. However, the feedback capacitor does not need to be duplicated if there is a single amplifier. The $V_{CM}x$ outputs can be combined using series resistors. An example for $R_{FB}2$ is shown in Figure 95.

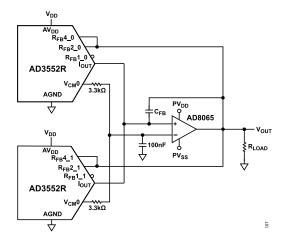


Figure 95. Dual DAC Configuration with RFB2 x

To obtain the same voltage output as when using a single DAC, both DACs must be updated simultaneously with the same code. The most efficient way to do this is using the DAC_PAGE register for a direct update or the INPUT_PAGE register for an update via the LDAC pin or a software LDAC command.

LAYOUT GUIDELINES

The pin configuration of the AD3552R, shown in Figure 13, is arranged in a way that facilitates the layout of the EVAL-AD3552R, which is shown in Figure 13. Most digital high speed lines are located on one side of the chip, with the analog functions of each DAC symmetrically distributed along the other three sides. This arrangement allows routing of the digital lines straight away from the analog functions, the placement of one amplifier on each side of the chip, and the external reference on the left side, as seen in Figure 96.

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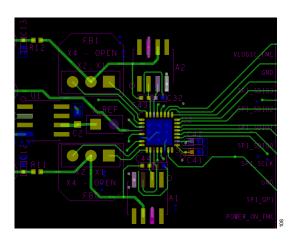


Figure 96. EVAL-AD3552R Component Arrangement and Layout

The following list is a few recommendations to observe to obtain the best performance:

- ▶ Keep I_{OUT} lines as short and thin as possible. This signal is responsible for the slewing of the amplifier to the final value. Therefore, the parasitic capacitance on this line increases the settling time. Use a feedback capacitor with a small footprint to minimize parasitic capacitance to the ground plane.
- Keep the I_{OUT} line away from repetitive signals, such as clocks and analog signals with high voltage excursion, because this is a high impedance line that can easily pick up electromagnetic interference.

- Connect the exposed pad of the AD3552R to the ground plane with several vias to minimize thermal drift. Note that the chip can dissipate up to 250 mW.
- Keep switching regulators and fast dV/dt signals away from the feedback loops of the DAC. Any μA induced on these lines becomes a mV at the output of the DAC.
- ▶ Do not overlap analog and digital signals. If a crossing cannot be avoided, it must be done at 45° or 90°.
- ▶ Route digital lines using traces with a constant characteristic impedance to avoid signal integrity problems that result in timing violations in DDR mode and crosstalk between signals. The traces must have a continuous ground plane underneath. When changing layers, ensure that the destination layer is referred to another ground plane and the traces have the same characteristic impedance. Place a via connecting both ground planes near the via of the digital line. If the destination layer is referred to a power plane, it must be continuous along the path of the line and a decoupling capacitor between power and ground must be placed close to the via of the digital line.

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OUTLINE DIMENSIONS

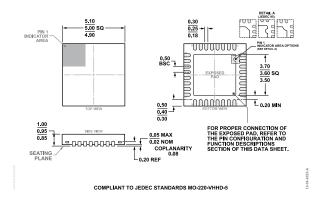


Figure 97. 32-Lead Lead Frame Chip Scale Package [LFCSP] 5 mm × 5 mm Body and 0.95 mm Package Height (CP-32-30) Dimensions shown in millimeters

Updated: October 29, 2021

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Packing Quantity	Package Option
AD3552RBCPZ16	-40°C to +105°C	LFCSP:LEADFRM CHIP SCALE		CP-32-30
AD3552RBCPZ16-RL7	-40°C to +105°C	LFCSP:LEADFRM CHIP SCALE	Reel, 1500	CP-32-30

¹ Z = RoHS Compliant Part.

EVALUATION BOARDS

Model ^{1,}	Description
EVAL-AD3552RFMC1Z	AD3552R Evaluation Board optimized for Settling Time
EVAL-AD3552RFMC2Z	AD3552R Evaluation Board optimized for DC Accuracy
EVAL-SDP-CH1Z	SDP High Speed Controller Board

¹ Z = RoHS Compliant Part.

